



# LC651154N, 651154F, 651154L, LC651152N, 651152F, 651152L

## Four-Bit CMOS Microcontrollers for Small-Scale Control Applications

### Preliminary

### Overview

The LC651154N/F/L and the LC651152N/F/L are the small-scale control application versions of Sanyo's LC6500 series of 4-bit single-chip CMOS microcontrollers, and feature the same basic architecture and instruction set. These microcontrollers include an 8-input 8-bit A/D converter and are appropriate for use in a wide range of applications, from applications with a small number of circuits and controls that were previously implemented in standard logic to applications with a larger scale such as home appliances, automotive equipment, communications equipment, office equipment, and audio equipment such as decks and players. Also note that since these ICs provide the same basic functions (certain functions and specifications do differ) as, and are pin compatible with the earlier LC651104N/F/L and LC651102N/F/L, they can replace those ICs in most cases.

### Features

- Fabricated in a CMOS process for low power (A standby function that can be invoked under program control is also provided.)
- ROM/RAM
  - LC651154N/F/L — ROM: 4K × 8 bits,  
RAM: 256 × 4 bits
  - LC651152N/F/L — ROM: 2K × 8 bits,  
RAM: 256 × 4 bits
- Instruction set: The 80-instruction set common to the LC6500 family
- Wide operating supply voltage range: 2.2 to 6.0 V (L versions)
- Instruction cycle time: 0.92 μs (F versions)
- On-chip serial I/O function
- Flexible I/O ports
  - Number of ports: 6 ports with a total of 22 pins
  - All ports:
    - Are I/O ports
    - I/O voltage handling capacity: 15 V (maximum) (Open-drain specification C, D, E, and F ports only)
    - Output current: 20 mA (maximum) sink current (Are capable of directly driving an LED.)
- Support options to match application system specifications
  - A. Open-drain output, internal pull-up resistor specification: All ports, in bit units
  - B. Output level at reset specification: Ports C and D can be specified to go to the high or low level in 4-bit units.
- Interrupt function
  - Timer interrupts through an interrupt vector (Can be tested under program control)
  - $\overline{\text{INT}}$  pin and serial I/O full/empty interrupts through an interrupt vector (Can be tested under program control)
- Stack levels: 8 (Shared with the interrupt system.)
- Timers: 4-bit variable prescaler and 8-bit programmable timers
- Clock oscillator options that match a wide range of system specifications
  - Oscillator circuit options:
    - Two-pin RC oscillator (N and L versions)
    - Two-pin ceramic oscillator (N, F, and L versions)
  - Clock divider circuit options:
    - No divider, built-in divide-by-3, built-in divide-by-4 (N and L versions)
- Continuous square wave output (with a period 64 times the cycle time)
- A/D converter (successive approximation)
  - 8-bit precision with 8 input channels
- Watchdog timer

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## LC651154N, 651154F, 651154L, 651152N, 651152F, 651152L

- RC circuit time constant
- Optional watchdog timer reset function from an external pin

**Function Table**

| Parameter         |                                 | LC651154N/1152N  | LC651154F/1152F   | LC651154L/1152L   |
|-------------------|---------------------------------|--|---|---|
| Memory            | ROM                             | 4096 × 8 bits (1154N)<br>2048 × 8 bits (1152N)   | 4096 × 8 bits (1154F)<br>2048 × 8 bits (1152F)            | 4096 × 8 bits (1154L)<br>2048 × 8 bits (1152L)            |
|                   | RAM                             | 256 × 4 bits (1154/1152N)  | 256 × 4 bits (1154/1152F)                                 | 256 × 4 bits (1154/1152L)                                 |
| Instructions      | Instruction set                 | 80   | 80  | 80  |
|                   | Table reference                 | Supported  | Supported   | Supported   |
| On-chip functions | Interrupts                      | 1 external, 1 internal   | 1 external, 1 internal                                    | 1 external, 1 internal                                    |
|                   | Timers                          | 4-bit variable prescaler<br>+ 8-bit timers   | 4-bit variable prescaler<br>+ 8-bit timers                | 4-bit variable prescaler<br>+ 8-bit timers                |
|                   | Stack levels                    | 8  | 8   | 8   |
|                   | Standby function                | Standby mode entered by the<br>HALT instruction supported                                  | Standby mode entered by the<br>HALT instruction supported | Standby mode entered by the<br>HALT instruction supported |
| I/O ports         | Number of ports                 | 22 I/O port pins   | 22 I/O port pins  | 22 I/O port pins  |
|                   | Serial port                     | Input and output in 4 or 8 bit units   | Input and output in 4 or 8 bit units                      | Input and output in 4 or 8 bit units                      |
|                   | I/O voltage handling capability | 15 V max.  | 15 V max.   | 15 V max.   |
|                   | Output current                  | 10 mA typ. 20 mA max.  | 10 mA typ. 20 mA max.                                     | 10 mA typ. 20 mA max.                                     |
|                   | I/O circuit types               | Open drain (n-channel) and pull-up resistor output options can be specified in 1-bit units |   |   |
|                   | Output level at reset           | A high or low level output can be selected in port units (ports C and D only)              |   |   |
|                   | Square wave output              | Supported  | Supported   | Supported   |
| Characteristics   | Minimum cycle time              | 2.77 μs (V <sub>DD</sub> ≥ 3 V)  | 0.92 μs (V <sub>DD</sub> ≥ 2.5 V)                         | 3.84 μs (V <sub>DD</sub> ≥ 2.2 V)                         |
|                   | Supply voltage                  | 3 to 6 V   | 2.5 to 6 V  | 2.2 to 6 V  |
|                   | Current drain                   | 1.5 mA typ.  | 2 mA typ.   | 1.5 mA typ.   |
| Oscillator        | Oscillator element              | RC (800/400 kHz typ.)<br>Ceramic (400 k, 800 k, 1 MHz, 4 MHz)                              | Ceramic 4 MHz   | RC (400 kHz typ.)<br>Ceramic (400 k, 800 k, 1 MHz, 4 MHz) |
|                   | Divider circuit option          | 1/1, 1/3, 1/4  | 1/1   | 1/1, 1/3, 1/4   |
| Other items       | Package                         | DIP30S-D, MFP30S, SSOP30   | DIP30S-D, MFP30S, SSOP30                                  | DIP30S-D, MFP30S, SSOP30                                  |

Note: Recommendations for oscillator elements and oscillator circuit constants will be announced as the recommended circuits for these ICs are determined. Verify the progress of these developments periodically.

## LC651154N, 651154F, 651154L, 651152N, 651152F, 651152L

### Differences between the LC651154N/1152N and the LC651104N/1102N.

The table below lists the points that require care when converting an existing product that uses the LC651104N/1102N to use the LC651154N/1152N.

| Parameter   |  | LC651154N/1152N  | LC651104N/1102N  |
|---|--|--|--|
| Allowable power dissipation   | Pdmax (1) : DIP                            | 310 mW   | 250 mW   |
|   | Pdmax (2) : MFP                            | 220 mW   | 150 mW   |
|   | Pdmax (3) : SSOP                           | 160 mW   | (No corresponding package)   |
| Oscillator characteristics<br>Ceramic oscillator<br>Oscillator frequency<br>2-pin RC oscillator<br>Oscillator frequency | f <sub>COSC</sub><br>[OSC1, OSC2]          | Oscillator frequency precision: within ±2%<br>Changes in the recommended oscillator constants (See table 1.)                                       | Oscillator frequency precision: within ±4%   |
|   | f <sub>MOSC</sub><br>[OSC1, OSC2]          | 800 kHz typ. (V <sub>DD</sub> = 3 to 6 V)<br>Constants changed: Rext = 5.6 kΩ ±1 %<br>Frequency variability (sample to sample):<br>587 to 1298 kHz | 900 kHz typ. (V <sub>DD</sub> = 4 to 6 V)<br>Constants changed: Rext = 4.7 kΩ ±1 %<br>Frequency variability (sample to sample):<br>634 to 1278 kHz |
|   |  | 400 kHz typ. (V <sub>DD</sub> = 3 to 6 V)<br>Frequency variability (sample to sample):<br>290 to 616 kHz   | 400 kHz typ. (V <sub>DD</sub> = 3 to 6 V)<br>Frequency variability (sample to sample):<br>276 to 742 kHz   |
|   |  |  |  |
| Pull-up resistors   | Ru [RES]                                   | 200 to 800 kΩ (500 kΩ typ.)  | 300 to 700 kΩ (500 kΩ typ.)  |
| Serial clock input clock cycle time   | t <sub>CKCY</sub> (1) [SCK]                | min. 2.0 μs  | min. 3.0 μs  |
| A/D converter characteristics<br>AV+ = V <sub>DD</sub><br>AV- = V <sub>SS</sub>   | Operating voltage                          | V <sub>DD</sub> = 3 to 6 V   | V <sub>DD</sub> = 4 to 6 V   |
|   | Reference input current<br>IRIF [AV+, AV-] | 200 to 800 μA (500 μA typ.)  | 75 to 300 μA (150 μA typ.)   |
| Watchdog timer<br>Cw = 0.047 ±5% μF<br>Rw = 680 ±1% kΩ<br>RI = 100 ±1% Ω  |  | V <sub>DD</sub> = 3 to 6 V   | V <sub>DD</sub> = 4 to 6 V   |
| Package   |  | DIP30S-D, MFP30S<br>An SSOP30 version was added.   | DIP30S-D, MFP30S   |

### Differences between the LC651154F/1152F and the LC651104F/1102F.

The table below lists the points that require care when converting an existing product that uses the LC651104F/1102F to use the LC651154F/1152F.

| Parameter   |  | LC651154F/1152F  | LC651104F/1102F  |
|---|--|--|--|
| Allowable power dissipation   | Pdmax (1) : DIP                            | 310 mW   | 250 mW   |
|   | Pdmax (2) : MFP                            | 220 mW   | 150 mW   |
|   | Pdmax (3) : SSOP                           | 160 mW   | (No corresponding package)   |
| Operating supply voltage  | V <sub>DD</sub>                            | 2.5 to 6 V   | 4 to 6 V   |
| Low-level input voltage   | V <sub>IL</sub> (n)                        | Specifications for V <sub>DD</sub> = 4 to 6 V<br>The specifications for V <sub>DD</sub> = 2.5 to 6 V were added. | Specifications for V <sub>DD</sub> = 4 to 6 V  |
| Oscillator characteristics<br>Ceramic oscillator<br>Oscillator frequency        | f <sub>COSC</sub><br>[OSC1, OSC2]          | Oscillator frequency precision: within ±2 %  | Oscillator frequency precision: within ±4 %  |
| Pull-up resistors   | Ru [RES]                                   | 200 to 800 kΩ (500 kΩ typ.)  | 300 to 700 kΩ (500 kΩ typ.)  |
| A/D converter characteristics<br>AV+ = V <sub>DD</sub><br>AV- = V <sub>SS</sub> | Operating voltage                          | AD speed 1/1 : V <sub>DD</sub> = 3.5 to 6 V<br>AD speed 1/2 : V <sub>DD</sub> = 3 to 6 V                         | AD speed 1/1 : V <sub>DD</sub> = 4.5 to 6 V<br>AD speed 1/2 : V <sub>DD</sub> = 4 to 6 V |
|   | Reference input current<br>IRIF [AV+, AV-] | 200 to 800 μA (500 μA typ.)  | 75 to 300 μA (150 μA typ.)   |
| Package   |  | DIP30S-D, MFP30S<br>An SSOP30 version was added.   | DIP30S-D, MFP30S   |

**Differences between the LC651154L/1152L and the LC651104L/1102L.**

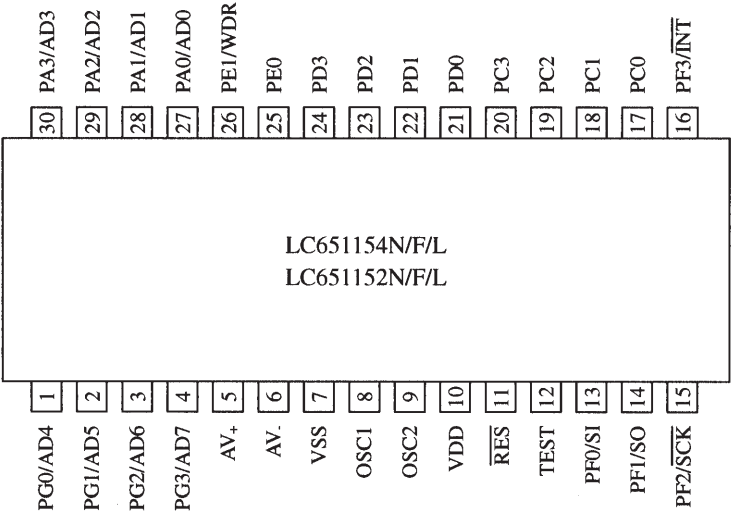
The table below lists the points that require care when converting an existing product that uses the LC651104L/1102L to use the LC651154L/1152L.

| Parameter                           |                                   | LC651154L/1152L  | LC651104L/1102L   |
|-------------------------------------|-----------------------------------|--|---|
| Allowable power dissipation         | Pdmax (1) : DIP                   | 310 mW   | 250 mW  |
|                                     | Pdmax (2) : MFP                   | 220 mW   | 150 mW  |
|                                     | Pdmax (3) : SSOP                  | 160 mW   | (No corresponding package)                                  |
| Operating supply voltage            | V <sub>DD</sub>                   | 2.2 to 6 V   | 2.5 to 6 V  |
| Oscillator characteristics          |                                   | Oscillator frequency precision: within ±2%                     | Oscillator frequency precision: within ±4%                  |
| Ceramic oscillator                  | f <sub>COSC</sub><br>[OSC1, OSC2] | Changes in the recommended oscillator constants (See table 1.) |   |
| Oscillator frequency                |                                   |  |   |
| 2-pin RC oscillator                 | f <sub>MOSC</sub><br>[OSC1, OSC2] | 400 kHz typ. (V <sub>DD</sub> = 2.2 to 6 V)                    | 400 kHz typ. (V <sub>DD</sub> = 2.5 to 6 V)                 |
| Oscillator frequency                |                                   | Frequency variability (sample to sample):<br>290 to 841 kHz    | Frequency variability (sample to sample):<br>276 to 742 kHz |
| Pull-up resistors                   | R <sub>u</sub> [RES]              | 200 to 800 kΩ (500 kΩ typ.)                                    | 300 to 700 kΩ (500 kΩ typ.)                                 |
| Serial clock input clock cycle time | t <sub>CKCY</sub> (1) [SCK]       | min. 2.0 μs  | min. 6.0 μs   |
| A/D converter characteristics       | Operating voltage                 | V <sub>DD</sub> = 3 to 6 V                                     | V <sub>DD</sub> = 4 to 6 V                                  |
| AV+ = V <sub>DD</sub>               | Reference input current           | 200 to 800 μA (500 μA typ.)                                    | 75 to 300 μA (150 μA typ.)                                  |
| AV- = V <sub>SS</sub>               | IRIF [AV+, AV-]                   |  |   |
| Watchdog timer                      |                                   | V <sub>DD</sub> = 2.2 to 6.0 V                                 | V <sub>DD</sub> = 2.5 to 6.0 V                              |
| Package                             |                                   | DIP30S-D, MFP30S<br>An SSOP30 version was added.               | DIP30S-D, MFP30S  |

Caution: Perform a full system evaluation and inspection after replacing the microcontroller.

Pin Assignment

The pin assignment is the same for the DIP, MFP, and SSOP packages.



## Pin Functions

OSC1, OSC2: Connections for the oscillator capacitor and resistor or ceramic element

$\overline{\text{RES}}$ : Reset

PA0 to PA3: Common I/O ports A0 to A3

PC0 to PC3: Common I/O ports C0 to C3

PD0 to PD3: Common I/O ports D0 to D3

PE0 to PE3: Common I/O ports E0 to E3

PF0 to PF3: Common I/O ports F0 to F3

PG0 to PG3: Common I/O ports G0 to G3

Note: Pins SI, SO,  $\overline{\text{SCK}}$ , and  $\overline{\text{INT}}$  are shared function pins also used as PF0:3.

TEST: IC testing.

$\overline{\text{INT}}$ : Interrupt request input

SI: Serial input

SO: Serial output

$\overline{\text{SCK}}$ : Serial clock input output

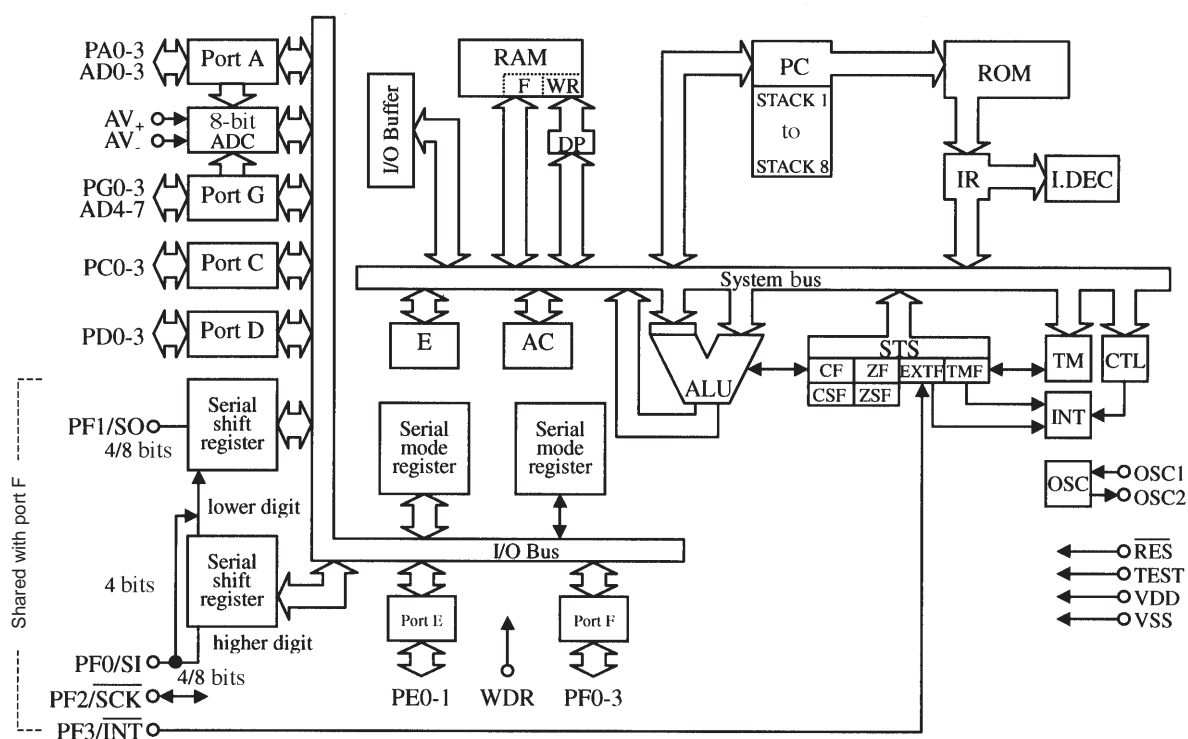
AD0 to AD7: A/D converter analog inputs

AV<sub>+</sub>, AV<sub>-</sub>: A/D converter reference voltage inputs

WDR: Watchdog timer reset input

## System Block Diagram

LC651154N/F/L, LC651152N/F/L



RAM: Data memory

F: Flag

WR: Working register

AC: Accumulator

ALU: Arithmetic and logic unit

DP: Data pointer

E: E register

CTL: Control register

OSC: Oscillator circuit

TM: Timer

STS: Status register

ROM: Program memory

PC: Program counter

INT: Interrupt control

IR: Instruction register

I.DEC: Instruction decoder

CF, CSF: Carry flag and carry save flag

ZF, ZSF: Zero flag and zero save flag

EXTF: External interrupt request flag

TMF: Internal interrupt request flag

## Development Support

The following are provided for development with the LC651154 and LC651152.

- User's manual  
See the "LC651104/1102 User's Manual."
- Development tools manual  
See the "Four-Bit Microcontroller EVA86000 Development Tools Manual."
- Software manual  
"LC65/66 Series Software Manual"
- Development tools
  - Program development (EVA86000 System)
  - On-chip EPROM microcontroller <LC65E1104> for program evaluation

## Pin Functions

| Symbol                             | Number of pins | I/O    | Function   | Option  | At reset  | Handling when unused   |
|------------------------------------|----------------|--------|--|---|---|--|
| V <sub>DD</sub><br>V <sub>SS</sub> | 1              | —<br>— | Power supply   | —   | —   | —  |
| OSC1                               | 1              | Input  | <ul style="list-style-type: none"> <li>Connection for the RC circuit or ceramic oscillator element used for the system clock oscillator</li> <li>Leave OSC2 open when an external clock input is used.</li> </ul>  | (1) Two-pin RC oscillator or external clock<br>(2) Two-pin ceramic oscillator<br>(3) Divider option<br>1. No divider<br>2. Divide-by-3<br>3. Divide-by-4  | —   | —  |
| OSC2                               | 1              | Output |  |   |   |  |
| PA0 to PA3/<br>AD0 to AD3          | 4              | I/O    | <ul style="list-style-type: none"> <li>I/O port A0 to A3<br/>Input in 4-bit units (IP instruction)<br/>Output in 4-bit units (OP instruction)<br/>Testing in 1-bit units (BP and BNP instructions)<br/>Set and reset in 1-bit units (SPB and RPB instructions)</li> <li>PA3 is used for standby mode control</li> <li>Application must assure that chattering does not occur on the PA3 input during HALT instruction execution.</li> <li>All four pins have shared functions<br/>PA0/AD0 - A/D converter input AD0<br/>PA1/AD1 - A/D converter input AD1<br/>PA2/AD2 - A/D converter input AD2<br/>PA3/AD3 - A/D converter input AD3</li> </ul> | (1) Open-drain output<br>(2) Pull-up resistor<br>Options (1) and (2) can be specified in bit units  | High-level output (The output n-channel transistors in the off state.)  | Select the open-drain output option and connect to V <sub>SS</sub> . |
| PC0 to PC3                         | 4              | I/O    | <ul style="list-style-type: none"> <li>I/O port C0 to C3<br/>The port functions are identical to those of PA0 to PA3. (See note.)</li> <li>The output during a reset can be selected to be either high or low as an option.<br/>Note: This port has no standby mode control function.</li> </ul>   | (1) Open-drain output<br>(2) Pull-up resistor<br>(3) High-level output during reset<br>(4) Low-level output during reset<br>• Options (1) and (2) can be specified in bit units<br>• Options (3) and (4) are specified 4 bits at a time | <ul style="list-style-type: none"> <li>High-level output</li> <li>Low-level output (Depending on option selected.)</li> </ul> | The same as for PA0 to PA3   |
| PD0 to PD3                         | 4              | I/O    | <ul style="list-style-type: none"> <li>I/O port D0 to D3<br/>The port functions and options are identical to those of PC0 to PC3.</li> </ul>   | The same as PC0 to PC3  | The same as PC0 to PC3  | The same as for PA0 to PA3   |

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| Symbol   | Number of pins | I/O   | Function   | Option  | At reset   | Handling when unused                            |
|--|----------------|-------|--|---|--|---|
| PE0-PE1/<br>WDR  | 2              | I/O   | <ul style="list-style-type: none"> <li>I/O port E0 to E1</li> <li>Input in 4-bit units (IP instruction)</li> <li>Output in 4-bit units (OP instruction)</li> <li>Set and reset in 1-bit units (SPB and RPB instructions)</li> <li>Testing in 1-bit units (BP and BNP instructions)</li> <li>PE0 also has a continuous pulse (64·T<sub>cyc</sub>) output function.</li> <li>PE1 becomes the watchdog reset pin WDR when selected for such as an option.</li> </ul>  | (1) Open-drain output<br>(2) Pull-up resistor<br>• Options (1) and (2) can be specified in bit units<br>(3) Normal port PE1<br>(4) Watchdog reset WDR<br>• Either options (3) and (4) may be specified. | High-level output (The output n-channel transistors in the off state.)   | Identical to those for PA0 to PA3               |
| PF0/SI<br>PF1/SO<br>PF2/ $\overline{\text{SCK}}$<br>PF3/ $\overline{\text{INT}}$ | 4              | I/O   | <ul style="list-style-type: none"> <li>I/O port F0 to F3</li> <li>The port functions and options are identical to those of PE0 to PE1 (See note.)</li> <li>PF0 to PF3 have shared functions as the serial interface pins and the <math>\overline{\text{INT}}</math> input.</li> <li>The function can be selected under program control.</li> <li>SI ... Serial input pin</li> <li>SO ... Serial output pin</li> <li><math>\overline{\text{SCK}}</math> ... Input and output of the serial clock signal</li> <li><math>\overline{\text{INT}}</math> ... Interrupt request input</li> <li>The serial I/O function can be switched between 4-bit and 8-bit transfers under program control.</li> <li>Note: There is no continuous pulse output function.</li> </ul> | Identical to those for PA0 to PA3   | Identical to those for PA0 to PA3<br>The serial port functions are disabled.<br>The interrupt source is set to $\overline{\text{INT}}$ . | Identical to those for PA0 to PA3               |
| PG0-PG3/<br>AD4-AD7  | 4              | I/O   | <ul style="list-style-type: none"> <li>I/O port G0 to G3</li> <li>The port functions and options are identical to those of PE0 to PE1 (See note.)</li> <li>Note: There is no continuous pulse output function.</li> <li>All four pins have shared functions.</li> <li>PG0/AD4 - A/D converter input AD4</li> <li>PG1/AD5 - A/D converter input AD5</li> <li>PG2/AD6 - A/D converter input AD6</li> <li>PG3/AD7 - A/D converter input AD7</li> </ul>  | Identical to those for PA0 to PA3   | Identical to those for PA0 to PA3  | Identical to those for PA0 to PA3               |
| AV <sub>+</sub>  | 1              | —     | A/D converter reference voltage input  | —   | —  | Connect to V <sub>SS</sub> .                    |
| AV <sub>-</sub>  | 1              | —     |  |   |  |   |
| $\overline{\text{RES}}$  | 1              | Input | <ul style="list-style-type: none"> <li>System reset input</li> <li>Applications must provide an external capacitor for the power-on reset.</li> <li>Apply a low level to this pin for 4 clock cycles to effect and reset start.</li> </ul>   | —   | —  | —   |
| TEST   | 1              | Input | <ul style="list-style-type: none"> <li>IC test pin</li> <li>This pin must be connected to V<sub>SS</sub> during normal operation.</li> </ul>   | —   | —  | This pin must be connected to V <sub>SS</sub> . |



## Oscillator Circuit Options

| Option                | Circuit | Conditions and other notes      |
|-----------------------|---------|---------------------------------|
| External clock        |         | The OSC2 pin must be left open. |
| Two-pin RC oscillator |         |                                 |
| Ceramic oscillator    |         |                                 |

## Divider Circuit Options

| Option                           | Circuit | Conditions and other notes   |
|----------------------------------|---------|--|
| No divider                       |         | <ul style="list-style-type: none"> <li>This option can be used with any of the three oscillator options.</li> <li>The oscillator frequency or external clock frequency must not exceed 1444 kHz. (LC651154N, LC651152N)</li> <li>The oscillator frequency or external clock frequency must not exceed 4330 kHz. (LC651154F, LC651152F)</li> <li>The oscillator frequency or external clock frequency must not exceed 1040 kHz. (LC651154L, LC651152L)</li> </ul> |
| Built-in divide-by-three circuit |         | <ul style="list-style-type: none"> <li>This option can only be used with the external clock and the ceramic oscillator options.</li> <li>The oscillator frequency or external clock frequency must not exceed 4330 kHz.</li> </ul>   |
| Built-in divide-by-four circuit  |         | <ul style="list-style-type: none"> <li>This option can only be used with the external clock and the ceramic oscillator options.</li> <li>The oscillator frequency or external clock frequency must not exceed 4330 kHz.</li> </ul>   |

Caution: The following tables summarize the oscillator and divider circuit options. Use care when selecting these options.

## Oscillator Options

### LC651154N, LC651152N

| Circuit type   | Frequency   | Divider option<br>(cycle time) | V <sub>DD</sub> range | Notes   |
|--|---|--------------------------------|-----------------------|---|
| Ceramic oscillator                                       | 400 kHz   | 1/1 (10 $\mu$ s)               | 3 to 6 V              | Cannot be used with the divide-by-three and divide-by-four options. |
|  | 800 kHz   | 1/1 (5 $\mu$ s)                | 3 to 6 V              |   |
|  |   | 1/3 (15 $\mu$ s)               | 3 to 6 V              |   |
|  |   | 1/4 (20 $\mu$ s)               | 3 to 6 V              |   |
|  | 1 MHz   | 1/1 (4 $\mu$ s)                | 3 to 6 V              |   |
|  |   | 1/3 (12 $\mu$ s)               | 3 to 6 V              |   |
|  |   | 1/4 (16 $\mu$ s)               | 3 to 6 V              |   |
| 4 MHz  |   | 1/3 (3 $\mu$ s)                | 3 to 6 V              | Cannot be used with the no divider circuit option.                  |
|  |   | 1/4 (4 $\mu$ s)                | 3 to 6 V              |   |
| External clock used with the 2-pin RC oscillator circuit | 200 k to 1444 kHz   | 1/1 (20 to 2.77 $\mu$ s)       | 3 to 6 V              |   |
|  | 600 k to 4330 kHz   | 1/3 (20 to 2.77 $\mu$ s)       | 3 to 6 V              |   |
|  | 800 k to 4330 kHz   | 1/4 (20 to 3.70 $\mu$ s)       | 3 to 6 V              |   |
| Two-pin RC   | Use the no divider circuit option and the recommended circuit constants. If using other circuit constants is unavoidable, the application must use a frequency identical to the external clock and observe the V <sub>DD</sub> range specification. |                                | 3 to 6 V              |   |
| External clock used with the ceramic oscillator option   | External clock drive is not possible. To use external clock drive, select the 2-pin RC oscillator option.   |                                |                       |   |

### LC651154F, LC651152F

| Circuit type   | Frequency   | Divider option<br>(cycle time) | V <sub>DD</sub> range | Notes |
|--|---|--------------------------------|-----------------------|-------|
| Ceramic oscillator                                       | 4 MHz   | 1/1 (1 $\mu$ s)                | 2.5 to 6 V            |       |
| External clock used with the 2-pin RC oscillator circuit | 200 k to 4330 kHz   | 1/1 (20 to 0.92 $\mu$ s)       | 2.5 to 6 V            |       |
| External clock used with the ceramic oscillator option   | External clock drive is not possible. To use external clock drive, select the 2-pin RC oscillator option. |                                |                       |       |

## LC651154L, LC651152L

| Circuit type   | Frequency   | Divider option<br>(cycle time) | V <sub>DD</sub> range | Notes   |
|--|---|--------------------------------|-----------------------|---|
| Ceramic oscillator                                       | 400 kHz   | 1/1 (10 $\mu$ s)               | 2.2 to 6 V            | Cannot be used with the divide-by-three and divide-by-four options.                             |
|  | 800 kHz   | 1/1 (5 $\mu$ s)                | 2.2 to 6 V            |   |
|  |   | 1/3 (15 $\mu$ s)               | 2.2 to 6 V            |   |
|  |   | 1/4 (20 $\mu$ s)               | 2.2 to 6 V            |   |
|  | 1 MHz   | 1/1 (4 $\mu$ s)                | 2.2 to 6 V            |   |
|  |   | 1/3 (12 $\mu$ s)               | 2.2 to 6 V            |   |
|  |   | 1/4 (16 $\mu$ s)               | 2.2 to 6 V            |   |
| 4 MHz  |   | 1/4 (4 $\mu$ s)                | 2.2 to 6 V            | Cannot be used with either the no divider circuit option or the divide-by-three circuit option. |
|  |   |                                |                       |   |
|  |   |                                |                       |   |
| External clock used with the 2-pin RC oscillator circuit | 200 k to 1040 kHz   | 1/1 (20 to 3.84 $\mu$ s)       | 2.2 to 6 V            |   |
|  | 600 k to 3120 kHz   | 1/3 (20 to 3.84 $\mu$ s)       | 2.2 to 6 V            |   |
|  | 800 k to 4160 kHz   | 1/4 (20 to 3.84 $\mu$ s)       | 2.2 to 6 V            |   |
| Two-pin RC   | Use the no divider circuit option and the recommended circuit constants. If using other circuit constants is unavoidable, the application must use a frequency identical to the external clock and observe the V <sub>DD</sub> range specification. |                                | 2.2 to 6 V            |   |
| External clock used with the ceramic oscillator option   | External clock drive is not possible. To use external clock drive, select the 2-pin RC oscillator option.   |                                |                       |   |

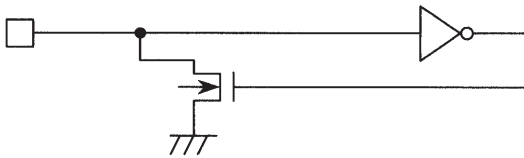
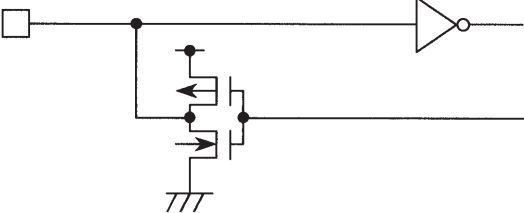
## Port C and D Output Level During Reset Option

The output level during a reset can be selected from the two options below in 4-bit units for the C and D ports.

| Option                         | Conditions and other notes   |
|--------------------------------|------------------------------|
| High-level output during reset | Ports C and D in 4-bit units |
| Low-level output during reset  | Ports C and D in 4-bit units |

## Port Output Type Option

The following two options may be selected for the I/O ports individually (bit units).

| Option                       | Circuit  | Applicable ports           |
|------------------------------|--|----------------------------|
| 1. Open-drain output         |  | Ports A, C, D, E, F, and G |
| 2. Built-in pull-up resistor |  |                            |

## Watchdog Reset Option

This option allows the PE1/WDR pin to be selected either to be used as the normal port PE1 or to be used as the watchdog reset pin WDR.

**LC651154N, 651154F, 651154L, 651152N, 651152F, 651152L**

**LC651154N, 651152N**

**Absolute Maximum Ratings at Ta = 25°C, VSS = 0 V**

| Parameter                   | Symbol               | Conditions  | Applicable pins and notes                    | Ratings                              | Unit |
|-----------------------------|----------------------|---|--|--------------------------------------|------|
| Maximum supply voltage      | V <sub>DD</sub> max  |   | V <sub>DD</sub>                              | –0.3 to +7.0                         | V    |
| Output voltage              | V <sub>O</sub>       |   | OSC2   | Allowed up to the generated voltage. |      |
| Input voltage               | V <sub>I</sub> (1)   |   | OSC1 *1                                      | –0.3 to V <sub>DD</sub> + 0.3        |      |
|                             | V <sub>I</sub> (2)   |   | TEST, RES, AV <sub>+</sub> , AV <sub>–</sub> | –0.3 to V <sub>DD</sub> + 0.3        |      |
| I/O voltage                 | V <sub>IO</sub> (1)  | PC0 to 3, PD0 to 3, PE0, 1, PF0 to 3  | Open-drain specification ports               | –0.3 to +15                          |      |
|                             | V <sub>IO</sub> (2)  | PC0 to 3, PD0 to 3, PE0, 1, PF0 to 3  | Pull-up resistor specification ports         | –0.3 to V <sub>DD</sub> + 0.3        |      |
|                             | V <sub>IO</sub> (3)  | PC0 to 3, PG0 to 3  |  | –0.3 to V <sub>DD</sub> + 0.3        |      |
| Peak output current         | I <sub>OP</sub>      |   | I/O ports                                    | –2 to +20                            | mA   |
| Average output current      | I <sub>OA</sub>      | Per single pin, averaged over 100 ms  | I/O ports                                    | –2 to +20                            |      |
|                             | ΣI <sub>OA</sub> (1) | The total current for PC0 to PC3, PD0 to PD3, and PE0 to PE1 *2               | PC0 to 3<br>PD0 to 3<br>PE0 to 1             | –15 to +100                          |      |
|                             | ΣI <sub>OA</sub> (2) | The total current for PF0 to PF3, PG0 to PG3, and PA0 to PA3 (See note 2.) *2 | PF0 to 3<br>PG0 to 3<br>PA0 to 3             | –15 to +100                          |      |
| Allowable power dissipation | Pd max (1)           | Ta = –40 to +85°C (DIP package)   |  | 310                                  | mW   |
|                             | Pd max (2)           | Ta = –40 to +85°C (MFP package)   |  | 220                                  |      |
|                             | Pd max (3)           | Ta = –40 to +85°C (SSOP package)  |  | 160                                  |      |
| Operating temperature       | Topr                 |   |  | –40 to +85                           | °C   |
| Storage temperature         | Tstg                 |   |  | –55 to +125                          |      |

**Allowable Operating Ranges at Ta = –40 to +85°C, VSS = 0 V, VDD = 3.0 to 6.0 V (Unless otherwise specified.)**

| Parameter                | Symbol              | Conditions                         | Applicable pins and notes                                      | Ratings             |     |                 | Unit |
|--------------------------|---------------------|------------------------------------|--|---------------------|-----|-----------------|------|
|                          |                     |                                    |  | min                 | typ | max             |      |
| Operating supply voltage | V <sub>DD</sub>     |                                    | V <sub>DD</sub>  | 3.0                 |     | 6.0             | V    |
| Standby supply voltage   | V <sub>ST</sub>     | RAM and register values retained*3 | V <sub>DD</sub>  | 1.8                 |     | 6.0             |      |
| High-level input voltage | V <sub>IH</sub> (1) | Output n-channel transistors off   | Ports C, D, E, and F with open-drain specifications            | 0.7 V <sub>DD</sub> |     | 13.5            |      |
|                          | V <sub>IH</sub> (2) | Output n-channel transistors off   | Ports C, D, E, and F with pull-up resistor specifications      | 0.7 V <sub>DD</sub> |     | V <sub>DD</sub> |      |
|                          | V <sub>IH</sub> (3) | Output n-channel transistors off   | Port A, G  | 0.7 V <sub>DD</sub> |     | V <sub>DD</sub> |      |
|                          | V <sub>IH</sub> (4) | Output n-channel transistors off   | The INT, SCK, and SI pins with open-drain specifications       | 0.8 V <sub>DD</sub> |     | 13.5            |      |
|                          | V <sub>IH</sub> (5) | Output n-channel transistors off   | The INT, SCK, and SI pins with pull-up resistor specifications | 0.8 V <sub>DD</sub> |     | V <sub>DD</sub> |      |
|                          | V <sub>IH</sub> (6) | V <sub>DD</sub> = 1.8 to 6.0 V     | RES  | 0.8 V <sub>DD</sub> |     | V <sub>DD</sub> |      |
|                          | V <sub>IH</sub> (7) | External clock specifications      | OSC1   | 0.8 V <sub>DD</sub> |     | V <sub>DD</sub> |      |

Continued on next page.

**LC651154N, 651154F, 651154L, 651152N, 651152F, 651152L**

Continued from preceding page.

| Parameter                                | Symbol                              | Conditions   | Applicable pins and notes  | Ratings  |                    |                      | Unit     |
|--|-------------------------------------|--|----------------------------|--|--------------------|----------------------|----------|
|  |                                     |  |                            | min  | typ                | max                  |          |
| Low-level input voltage                  | V <sub>IL</sub> (1)                 | Output n-channel transistors off   | V <sub>DD</sub> = 4 to 6 V | Port   | V <sub>SS</sub>    | 0.3 V <sub>DD</sub>  | V        |
|  | V <sub>IL</sub> (2)                 | Output n-channel transistors off   | V <sub>DD</sub> = 3 to 6 V | Port   | V <sub>SS</sub>    | 0.25 V <sub>DD</sub> |          |
|  | V <sub>IL</sub> (3)                 | Output n-channel transistors off   | V <sub>DD</sub> = 4 to 6 V | $\overline{\text{INT}}$ , $\overline{\text{SCK}}$ , SI | V <sub>SS</sub>    | 0.25 V <sub>DD</sub> |          |
|  | V <sub>IL</sub> (4)                 | Output n-channel transistors off   | V <sub>DD</sub> = 3 to 6 V | $\overline{\text{INT}}$ , $\overline{\text{SCK}}$ , SI | V <sub>SS</sub>    | 0.2 V <sub>DD</sub>  |          |
|  | V <sub>IL</sub> (5)                 | External clock specifications  | V <sub>DD</sub> = 4 to 6 V | OSC1   | V <sub>SS</sub>    | 0.25 V <sub>DD</sub> |          |
|  | V <sub>IL</sub> (6)                 | External clock specifications  | V <sub>DD</sub> = 3 to 6 V | OSC1   | V <sub>SS</sub>    | 0.2 V <sub>DD</sub>  |          |
|  | V <sub>IL</sub> (7)                 |  | V <sub>DD</sub> = 4 to 6 V | TEST   | V <sub>SS</sub>    | 0.3 V <sub>DD</sub>  |          |
|  | V <sub>IL</sub> (8)                 |  | V <sub>DD</sub> = 3 to 6 V | TEST   | V <sub>SS</sub>    | 0.25 V <sub>DD</sub> |          |
|  | V <sub>IL</sub> (9)                 |  | V <sub>DD</sub> = 4 to 6 V | $\overline{\text{RES}}$                                | V <sub>SS</sub>    | 0.25 V <sub>DD</sub> |          |
|  | V <sub>IL</sub> (10)                |  | V <sub>DD</sub> = 3 to 6 V | $\overline{\text{RES}}$                                | V <sub>SS</sub>    | 0.2 V <sub>DD</sub>  |          |
| Operating frequency (cycle time)         | f <sub>op</sub> (T <sub>cyc</sub> ) | The clock may have a frequency up to 4.33 MHz when either the divide-by-three or divide-by-four internal divider circuit option is used. | V <sub>DD</sub> = 3 to 6 V |  | 200 (20)           | 1444 (2.77)          | kHz (μs) |
| External clock conditions                |                                     |  |                            |  |                    |                      |          |
| Frequency                                | text                                | Figure 1.  | V <sub>DD</sub> = 3 to 6 V | OSC1   | 200                | 4330                 | kHz      |
| Pulse width                              | textH, textL                        | Either the divide-by-three or divide-by-four internal divider circuit must be used if the clock frequency exceeds 1.444 MHz.             | V <sub>DD</sub> = 3 to 6 V | OSC1   | 69                 |                      | ns       |
| Rise and fall times                      | textR, textF                        |  | V <sub>DD</sub> = 3 to 6 V | OSC1   |                    | 50                   |          |
| Recommended oscillator circuit constants | Cext<br>Rext                        | Figure 2   | V <sub>DD</sub> = 3 to 6 V | OSC1, OSC2   | 270 ±5%<br>12 ±1%  |                      | pF<br>kΩ |
| Two-pin RC oscillator                    | Cext<br>Rext                        | Figure 2   | V <sub>DD</sub> = 3 to 6 V | OSC1, OSC2   | 270 ±5%<br>5.6 ±1% |                      | pF<br>kΩ |
| Ceramic oscillator *4                    |                                     | Figure 3   |                            |  | See table 1.       |                      |          |

**Electrical Characteristics at Ta = –40 to +85°C, V<sub>SS</sub> = 0 V, V<sub>DD</sub> = 3.0 to 6.0 V (Unless otherwise specified.)**

| Parameter                 |                              | Symbol              | Conditions   | Applicable pins and notes   | Ratings               |                     |                     | Unit |
|---------------------------|------------------------------|---------------------|--|---|-----------------------|---------------------|---------------------|------|
|                           |                              |                     |  |   | min                   | typ                 | max                 |      |
| High-level input current  |                              | I <sub>IH</sub> (1) | • Output n-channel transistors off (Including the n-channel transistor off leakage current.)<br>• V <sub>IN</sub> = 13.5 V                             | Ports C, D, E and F with the open-drain specifications  |                       |                     | 5.0                 | μA   |
|                           |                              | I <sub>IH</sub> (2) | • Output n-channel transistors off (Including the n-channel transistor off leakage current.)<br>• V <sub>IN</sub> = V <sub>DD</sub>                    | Ports A and G with the open-drain specifications  |                       |                     | 1.0                 |      |
|                           |                              | I <sub>IH</sub> (3) | When an external clock is used, V <sub>IN</sub> = V <sub>DD</sub>  | OSC1  |                       |                     | 1.0                 |      |
| Low-level input current   |                              | I <sub>IL</sub> (1) | • Output n-channel transistors off<br>• V <sub>IN</sub> = V <sub>SS</sub>  | Ports with the open-drain specifications  | –1.0                  |                     |                     | mA   |
|                           |                              | I <sub>IL</sub> (2) | • Output n-channel transistors off<br>• V <sub>IN</sub> = V <sub>SS</sub>  | Ports with the pull-up resistor specifications  | –1.3                  | –0.35               |                     |      |
|                           |                              | I <sub>IL</sub> (3) | V <sub>IN</sub> = V <sub>SS</sub>  | $\overline{RES}$  | –45                   | –10                 |                     | μA   |
|                           |                              | I <sub>IL</sub> (4) | When an external clock is used, V <sub>IN</sub> = V <sub>SS</sub>  | OSC1  | –1.0                  |                     |                     |      |
| High-level output voltage |                              | V <sub>OH</sub> (1) | • I <sub>OH</sub> = –50 μA<br>• V <sub>DD</sub> = 4.0 to 6.0 V   | Ports with the pull-up resistor specifications  | V <sub>DD</sub> – 1.2 |                     |                     | V    |
|                           |                              | V <sub>OH</sub> (2) | I <sub>OH</sub> = –10 μA   | Ports with the pull-up resistor specifications  | V <sub>DD</sub> – 0.5 |                     |                     |      |
| Low-level output voltage  |                              | V <sub>OL</sub> (1) | • I <sub>OL</sub> = 10 mA<br>• V <sub>DD</sub> = 4.0 to 6.0 V  | Port  |                       |                     | 1.5                 |      |
|                           |                              | V <sub>OL</sub> (2) | When I <sub>OL</sub> = 1 mA and the I <sub>OL</sub> for each port is 1 mA or less.   | Port  |                       |                     | 0.5                 |      |
| Schmitt characteristics   | Hysteresis voltage           | V <sub>HIS</sub>    |  | $\overline{RES}$ , $\overline{INT}$ , $\overline{SCK}$ , SI, and OSC1 with Schmitt specifications*5 |                       | 0.1 V <sub>DD</sub> |                     |      |
|                           | High-level threshold voltage | V <sub>IH</sub>     |  |   | 0.4 V <sub>DD</sub>   |                     | 0.8 V <sub>DD</sub> |      |
|                           | Low-level threshold voltage  | V <sub>IL</sub>     |  |   | 0.2 V <sub>DD</sub>   |                     | 0.6 V <sub>DD</sub> |      |
| Current drain *6          |                              |                     |  |   |                       |                     |                     |      |
| Two-pin RC oscillator     |                              | IDDOP (1)           | • Operating, with the output n-channel transistors off<br>• With the ports at V <sub>DD</sub><br>• Figure 2, fosc = 800 kHz (typical)                  | V <sub>DD</sub>   |                       | 1.5                 | 4                   | mA   |
|                           |                              | IDDOP (2)           | • Figure 3, 4 MHz, divide-by-three circuit used  | V <sub>DD</sub>   |                       | 1.5                 | 5                   |      |
| Ceramic oscillator        |                              | IDDOP (3)           | • Figure 3, 4 MHz, divide-by-four circuit used   | V <sub>DD</sub>   |                       | 1.5                 | 4                   |      |
|                           |                              | IDDOP (4)           | • Figure 3, 400 kHz  | V <sub>DD</sub>   |                       | 1.0                 | 2.5                 |      |
|                           |                              | IDDOP (5)           | • Figure 3, 800 kHz  | V <sub>DD</sub>   |                       | 1.5                 | 4                   |      |
| External clock            |                              | IDDOP (6)           | • 200 kHz to 1444 kHz, no divider circuit<br>• 600 kHz to 4330 kHz, divide-by-three circuit used<br>• 800 kHz to 4330 kHz, divide-by-four circuit used | V <sub>DD</sub>   |                       | 1.5                 | 5                   |      |
| Standby mode              |                              | IDDst               | Output n-channel transistors off, V <sub>DD</sub> = 6 V<br>Ports at V <sub>DD</sub> , V <sub>DD</sub> = 3 V  | V <sub>DD</sub>   |                       | 0.05                | 10                  | μA   |
|                           |                              |                     |  | V <sub>DD</sub>   |                       | 0.025               | 5                   |      |

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**LC651154N, 651154F, 651154L, 651152N, 651152F, 651152L**

Continued from preceding page.

| Parameter                                     | Symbol                  | Conditions  | Applicable pins and notes                            | Ratings                   |                              |                            | Unit          |
|---|-------------------------|---|--|---------------------------|------------------------------|----------------------------|---------------|
|   |                         |   |  | min                       | typ                          | max                        |               |
| Oscillator characteristics                    |                         |   |  |                           |                              |                            |               |
| Ceramic oscillator<br>Oscillator frequency    | $f_{\text{CFOSC}}^{*7}$ | <ul style="list-style-type: none"> <li>Figure 3, <math>f_o = 400</math> kHz</li> <li>Figure 3, <math>f_o = 800</math> kHz</li> <li>Figure 3, <math>f_o = 1</math> MHz</li> <li>Figure 3, <math>f_o = 4</math> MHz, with the divide-by-three or divide-by-four circuit used.</li> </ul>        | OSC1, OSC2<br>OSC1, OSC2<br>OSC1, OSC2<br>OSC1, OSC2 | 392<br>784<br>980<br>3920 | 400<br>800<br>1000<br>4000   | 408<br>816<br>1020<br>4080 | kHz           |
| Oscillator stabilization time<br>(note 8)     | $t_{\text{CFS}}$        | <ul style="list-style-type: none"> <li>Figure 4, <math>f_o = 400</math> kHz</li> <li>Figure 4, <math>f_o = 800</math> kHz, 1 MHz, or 4 MHz, with the divide-by-three or divide-by-four circuit used.</li> </ul>   |  |                           |                              | 10<br>10                   | ms            |
| Two-pin RC oscillator<br>Oscillator frequency | $f_{\text{MOSC}}$       | <ul style="list-style-type: none"> <li>Figure 2, <math>C_{\text{ext}} = 270</math> pF <math>\pm 5\%</math></li> <li>Figure 2, <math>R_{\text{ext}} = 5.6</math> k<math>\Omega</math> <math>\pm 1\%</math></li> </ul>  | OSC1, OSC2   | 587                       | 800                          | 1298                       | kHz           |
|   |                         | <ul style="list-style-type: none"> <li>Figure 2, <math>C_{\text{ext}} = 270</math> pF <math>\pm 5\%</math></li> <li>Figure 2, <math>R_{\text{ext}} = 12</math> k<math>\Omega</math> <math>\pm 1\%</math></li> </ul>   | OSC1, OSC2   | 290                       | 400                          | 818                        |               |
| Pull-up resistor<br>I/O ports                 | RPP                     | <ul style="list-style-type: none"> <li>Output n-channel transistors off</li> <li><math>V_{\text{IN}} = V_{\text{SS}}</math>, <math>V_{\text{DD}} = 5</math> V</li> </ul>  | Pull-up resistor<br>specification ports              | 8                         | 14                           | 30                         | k $\Omega$    |
| $\overline{\text{RES}}$                       | Ru                      | $V_{\text{IN}} = V_{\text{SS}}$ , $V_{\text{DD}} = 5$ V   | $\overline{\text{RES}}$                              | 200                       | 500                          | 800                        |               |
| External reset characteristics<br>Reset time  | $t_{\text{RST}}$        |   |  |                           | See figure 5.                |                            |               |
| Pin capacitances                              | $C_p$                   | <ul style="list-style-type: none"> <li><math>f = 1</math> MHz</li> <li>With all pins other than the pin being tested at <math>V_{\text{IN}} = V_{\text{SS}}</math>.</li> </ul>  |  |                           | 10                           |                            | pF            |
| Serial clock                                  |                         |   |  |                           |                              |                            | $\mu\text{s}$ |
| Input clock cycle time                        | $t_{\text{CKCY}} (1)$   | Figure 6  | $\overline{\text{SCK}}$                              | 2.0                       |                              |                            |               |
| Output clock cycle time                       | $t_{\text{CKCY}} (2)$   | Figure 6  | $\overline{\text{SCK}}$                              |                           | $64 \times \text{TCYC}^{*9}$ |                            |               |
| Input clock low-level pulse width             | $t_{\text{CKL}} (1)$    | Figure 6  | $\overline{\text{SCK}}$                              | 1.0                       |                              |                            |               |
| Output clock low-level pulse width            | $t_{\text{CKL}} (2)$    | Figure 6  | $\overline{\text{SCK}}$                              |                           | $32 \times \text{TCYC}$      |                            |               |
| Input clock high-level pulse width            | $t_{\text{CKH}} (1)$    | Figure 6  | $\overline{\text{SCK}}$                              | 1.0                       |                              |                            |               |
| Output clock high-level pulse width           | $t_{\text{CKH}} (2)$    | Figure 6  | $\overline{\text{SCK}}$                              |                           | $32 \times \text{TCYC}$      |                            |               |
| Serial input                                  |                         |   |  |                           |                              |                            |               |
| Data setup time                               | $t_{\text{CK}}$         | <ul style="list-style-type: none"> <li>Stipulated with respect to the rising edge of <math>\overline{\text{SCK}}</math>.</li> <li>Figure 6</li> </ul>   | SI   | 0.4                       |                              |                            |               |
| Data hold time                                | $t_{\text{CKI}}$        |   | SI   | 0.4                       |                              |                            |               |
| Serial output                                 |                         |   |  |                           |                              |                            | $\mu\text{s}$ |
| Output delay time                             | $t_{\text{CKO}}$        | <ul style="list-style-type: none"> <li>Stipulated with respect to the falling edge of <math>\overline{\text{SCK}}</math>.</li> <li>With an external resistor of 1 k<math>\Omega</math> and an external capacitor of 50 pF on only the n-channel open-drain pins.</li> <li>Figure 6</li> </ul> | SO   |                           |                              | 0.6                        |               |

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| Parameter                     |                               | Symbol  | Conditions                 | Applicable pins and notes   | Ratings  |                            |                                   | Unit            |    |
|-------------------------------|-------------------------------|---|----------------------------|---|--|----------------------------|-----------------------------------|-----------------|----|
|                               |                               |   |                            |   | min  | typ                        | max                               |                 |    |
| Pulse output function         |                               |   |                            |   |  |                            |                                   |                 |    |
| Period                        | t <sub>PCY</sub>              | • Figure 7<br>• T <sub>CYC</sub> = 4 × system clock period<br>• With an external resistor of 1 kΩ and an external capacitor of 50 pF on only the n-channel open-drain pins. |                            | PE0   |  | 64 × T <sub>CYC</sub>      |                                   | μs              |    |
| High-level pulse width        | t <sub>PH</sub>               |   |                            | PE0   |  | 32 × T <sub>CYC</sub> ±10% |                                   |                 |    |
| Low-level pulse width         | t <sub>PL</sub>               |   |                            | PE0   |  | 32 × T <sub>CYC</sub> ±10% |                                   |                 |    |
| A/D converter characteristics | Resolution                    |   | V <sub>DD</sub> = 3 to 6 V |   |  | 8                          |                                   | bit             |    |
|                               | Absolute precision            | AV <sub>+</sub> = V <sub>DD</sub><br>AV <sub>-</sub> = V <sub>SS</sub>  |                            |   |  | ±1                         | ±2                                | LSB             |    |
|                               | Conversion time               | TCAD  |                            |   | 72<br>(T <sub>CYC</sub> = 2.77 μs)   |                            | 312<br>(T <sub>CYC</sub> = 12 μs) | μs              |    |
|                               |                               |   |                            |   | 141<br>(T <sub>CYC</sub> = 2.77 μs)  |                            | 612<br>(T <sub>CYC</sub> = 12 μs) |                 |    |
|                               | Input reference voltage       | AV <sub>+</sub>   |                            |   | AV <sub>+</sub>  | AV <sub>-</sub>            | V <sub>DD</sub>                   | V               |    |
|                               |                               | AV <sub>-</sub>   |                            |   | AV <sub>-</sub>  | V <sub>SS</sub>            | AV <sub>+</sub>                   |                 |    |
|                               | Input reference current range | IRIF  |                            | AV <sub>+</sub> = V <sub>DD</sub> , AV <sub>-</sub> = V <sub>SS</sub>           | AV <sub>+</sub> , AV <sub>-</sub>  | 200                        | 500                               | 800             | μA |
|                               | Analog input voltage range    | V <sub>AIN</sub>  |                            |   | AD0 to AD7   | AV <sub>-</sub>            |                                   | AV <sub>+</sub> | V  |
|                               | Analog port input current     | I <sub>AIN</sub>  |                            | Including the output off leakage current.<br>V <sub>AIN</sub> = V <sub>DD</sub> | AD0 to AD7 (The I/O shared function ports have open-drain specifications.) |                            |                                   | 1               | μA |
|                               |                               |   |                            | V <sub>AIN</sub> = V <sub>SS</sub>  |  | -1                         |                                   |                 |    |
| Watchdog timer                | Recommended constants*10      | Cw  | V <sub>DD</sub> = 3 to 6 V | WDR   |  | 0.1 ±5%                    |                                   | μF              |    |
|                               |                               | Rw  |                            | WDR   |  | 680 ±1%                    |                                   | kΩ              |    |
|                               |                               | RI  |                            | WDR   |  | 100 ±1%                    |                                   | Ω               |    |
|                               | Clear time (discharge)        | t <sub>WCT</sub>  | Figure 8                   | WDR   | 100  |                            |                                   | μs              |    |
|                               | Clear period (charge)         | t <sub>WCCY</sub>   | Figure 8                   | WDR   | 36   |                            |                                   | ms              |    |
|                               | Recommended constants*10      | Cw  | V <sub>DD</sub> = 3 to 6 V | WDR   |  | 0.047 ±5%                  |                                   | μF              |    |
|                               |                               | Rw  |                            | WDR   |  | 680 ±1%                    |                                   | kΩ              |    |
|                               |                               | RI  |                            | WDR   |  | 100 ±1%                    |                                   | Ω               |    |
|                               | Clear time (discharge)        | t <sub>WCT</sub>  | Figure 8                   | WDR   | 40   |                            |                                   | μs              |    |
|                               | Clear period (charge)         | t <sub>WCCY</sub>   | Figure 8                   | WDR   | 18   |                            |                                   | ms              |    |

- Notes: 1. Allowed up to the amplitude generated when the oscillator shown in figure 3 is used with the recommended circuit constants and driven by the IC.  
2. The average over a 100 ms period.  
3. The operating  $V_{DD}$  supply voltage must be maintained from the point the HALT instruction is executed until the IC has fully entered the standby state. Applications must also assure that no chattering occurs on the PA3 pin during the HALT instruction execution cycle.  
4. Recommended circuit constants that have been verified to oscillate stably according to the oscillator element manufacturer using the Sanyo-stipulated oscillator characteristics evaluation board.  
5. The OSC1 pin will have Schmitt characteristics when external clock oscillator is selected with the two-pin RC oscillator option.  
6. These are the results of testing using our (Sanyo's) characteristics evaluation board with the recommended circuit constants used as external components. The current flowing in the IC's output transistors and transistors that have pull-up resistors is not included.  
7.  $f_{CFOSC}$  is the frequency when the recommended circuit constants from table 1 are used as external components.  
8. Indicates the time required to achieve stable oscillation from the point  $V_{DD}$  rises above the lower limit of the operating voltage range.  
9.  $T_{CYC} = 4 \times$  the system clock period  
10. If the application could be used in an environment in which condensation is possible, extra care with respect to the leakage between PE1 and adjacent pins and leakage associated with external resistors and capacitor is required during design.



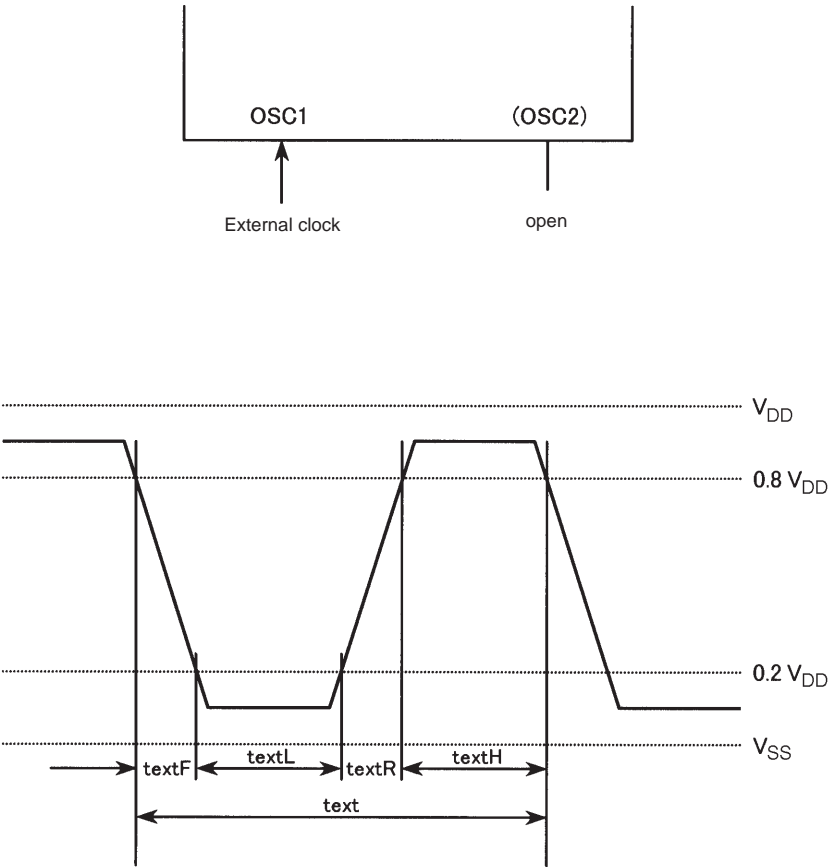


Figure 1 External Clock Input Waveform

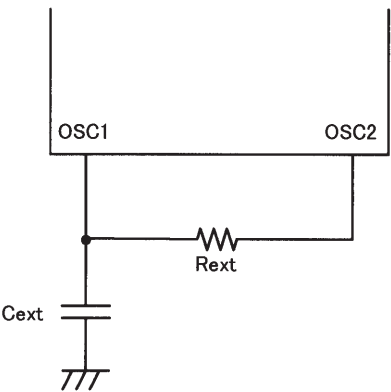


Figure 2 Two-Pin RC Oscillator Circuit

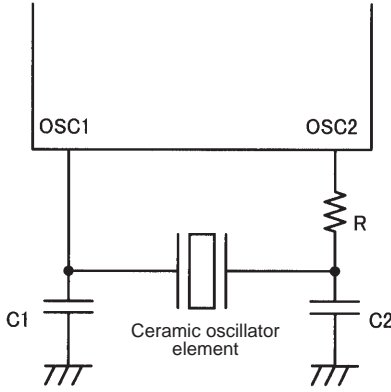


Figure 3 Ceramic Oscillator Circuit

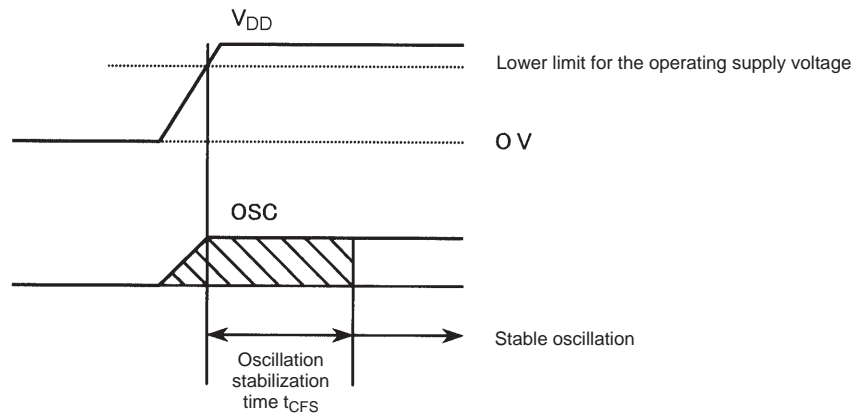


Figure 4 Oscillation Stabilization Time

Table 1 Recommended Ceramic Oscillator Circuit Constants

|  |    |                   |
|--|----|-------------------|
| 4 MHz (Murata Mfg. Co., Ltd.)<br>CSA4.00MG                                 | C1 | 33 pF $\pm 10\%$  |
|  | C2 | 33 pF $\pm 10\%$  |
|  | R  | 0 $\Omega$        |
| 4 MHz (Kyocera Corporation)<br>KBR4.0MSA<br>KBR4.0MKS (Internal capacitor) | C1 | 33 pF $\pm 10\%$  |
|  | C2 | 33 pF $\pm 10\%$  |
|  | R  | 0 $\Omega$        |
| 1 MHz (Murata Mfg. Co., Ltd.)<br>CSB1000J                                  | C1 | 100 pF $\pm 10\%$ |
|  | C2 | 100 pF $\pm 10\%$ |
|  | R  | 3.3 k $\Omega$    |
| 800 kHz (Murata Mfg. Co., Ltd.)<br>CSB800J                                 | C1 | 100 pF $\pm 10\%$ |
|  | C2 | 100 pF $\pm 10\%$ |
|  | R  | 3.3 k $\Omega$    |
| 400 kHz (Murata Mfg. Co., Ltd.)<br>CSB400P                                 | C1 | 220 pF $\pm 10\%$ |
|  | C2 | 220 pF $\pm 10\%$ |
|  | R  | 3.3 k $\Omega$    |

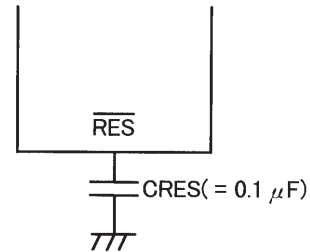


Figure 5 Reset Circuit

Note: If the power supply rise time is zero, the reset time when CRES = 0.1  $\mu$ F will be between 10 and 100 ms.  
If the power supply rise time is long, increase the value of CRES so that the reset time is at least 10 ms.

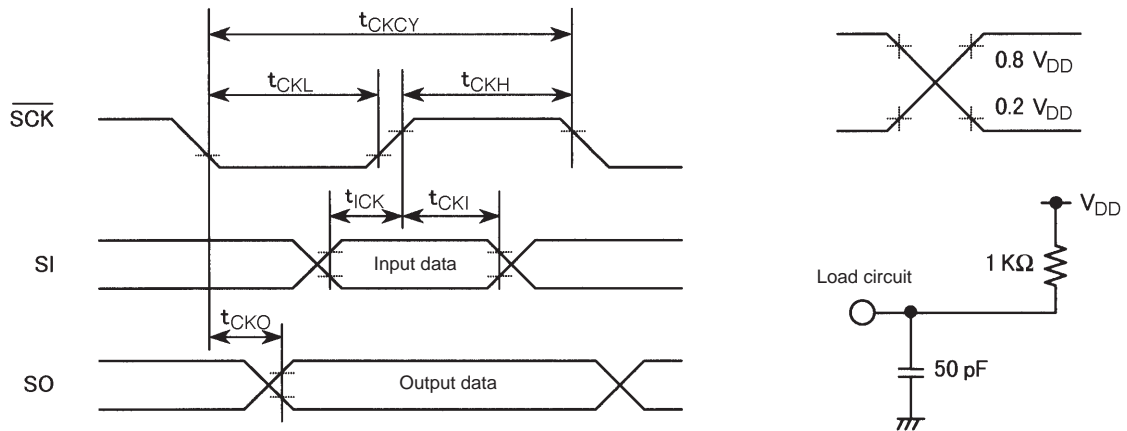
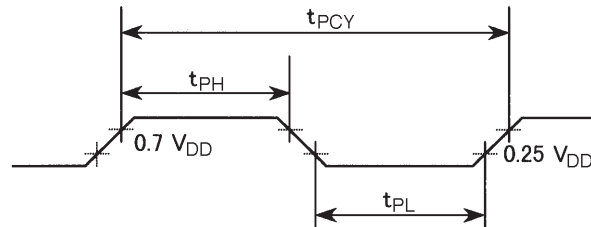
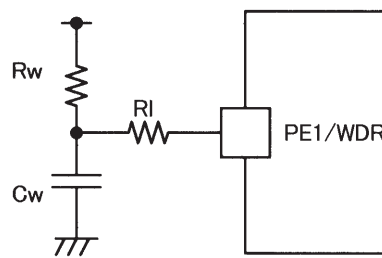


Figure 6 Serial I/O Timing



The load conditions are the same as those in figure 5.

Figure 7 Port PE0 Pulse Output Timing



$t_{WCCY}$ : The charge time due to the time constant of the circuit consisting of the external components  $C_w$ ,  $R_w$ , and  $R_I$ .  
 $t_{WCT}$ : The discharge time due to software processing.

Figure 8 Watchdog Timer Waveform

# RC Oscillator Characteristics for the LC651154N and LC651152N

Figure 9 shows the RC oscillator characteristics for the LC651154N and LC651152N.

However, the sample-to-sample variation in the LC651154N and LC651152N RC oscillator frequency described below does occur.

1) When:

$V_{DD} = 3.0$  to  $6.0$  V,  $T_a = -40$  to  $+85^\circ\text{C}$

External constants:  $C_{ext} = 270$  pF

$R_{ext} = 12.0$  k $\Omega$

$f_{MOSC}$  will be:

$290$  kHz  $\leq f_{MOSC} \leq 818$  kHz

2) When:

$V_{DD} = 3.0$  to  $6.0$  V,  $T_a = -40$  to  $+85^\circ\text{C}$

External constants:  $C_{ext} = 270$  pF

$R_{ext} = 5.6$  k $\Omega$

$f_{MOSC}$  will be:

$587$  kHz  $\leq f_{MOSC} \leq 1298$  kHz

Therefore, only the above circuit constants are recommended.

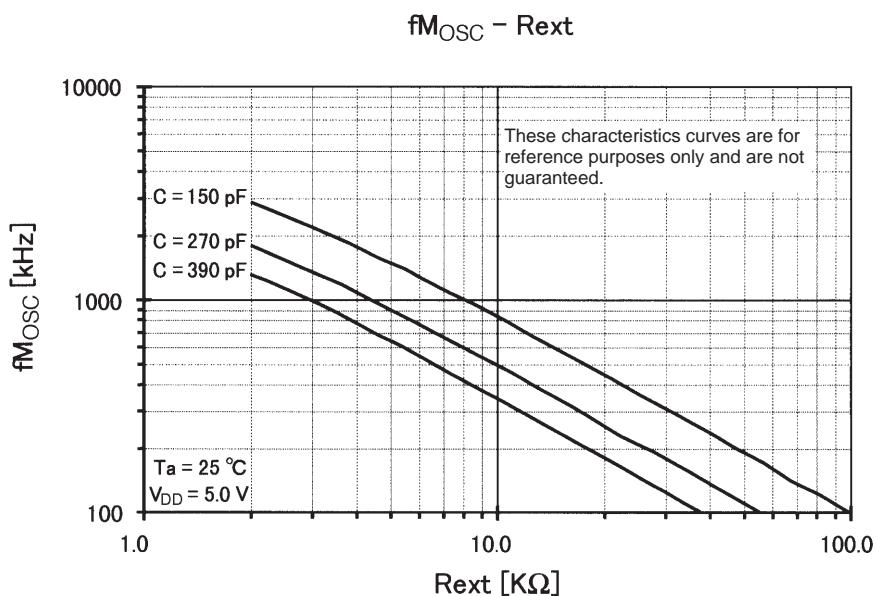
If use of circuit constants other than the above is unavoidable, they must be in the following ranges.

$C_{ext} = 150$  to  $390$  pF

$R_{ext} = 3$  to  $20$  k $\Omega$

(See figure 9.)

- Notes • The oscillator frequency must be in the range  $350$  to  $850$  kHz when  $V_{DD} = 5.0$  V and  $T_a = 25^\circ\text{C}$ .
- Applications must be designed to have adequate margins so that the oscillator frequency falls in the operating clock frequency range (see the oscillator divider option table) for the voltage range  $V_{DD} = 3.0$  to  $6.0$  V and for the temperature range  $T_a = -40$  to  $+85^\circ\text{C}$ .



## LC651154F, 651152F

Absolute Maximum Ratings at  $T_a = 25^\circ\text{C}$ ,  $V_{SS} = 0\text{ V}$ 

| Parameter                   | Symbol              | Conditions  | Applicable pins and notes                    | Ratings                              | Unit             |
|-----------------------------|---------------------|---|--|--------------------------------------|------------------|
| Maximum supply voltage      | $V_{DD\text{ max}}$ |   | $V_{DD}$                                     | -0.3 to +7.0                         | V                |
| Output voltage              | $V_O$               |   | OSC2   | Allowed up to the generated voltage. |                  |
| Input voltage               | $V_I$ (1)           |   | OSC1 *1                                      | -0.3 to $V_{DD} + 0.3$               |                  |
|                             | $V_I$ (2)           |   | TEST, RES, AV <sub>+</sub> , AV <sub>-</sub> | -0.3 to $V_{DD} + 0.3$               |                  |
| I/O voltage                 | $V_{IO}$ (1)        | PC0 to PC3, PD0 to PD3, PE0, 1, PF0 to PF3                                    | Open-drain specification ports               | -0.3 to +15                          |                  |
|                             | $V_{IO}$ (2)        | PC0 to PC3, PD0 to PD3, PE0, 1, PF0 to PF3                                    | Pull-up resistor specification ports         | -0.3 to $V_{DD} + 0.3$               |                  |
|                             | $V_{IO}$ (3)        | PA0 to PA3, PG0 to PG3  |  | -0.3 to $V_{DD} + 0.3$               |                  |
| Peak output current         | $I_{OP}$            |   | I/O ports                                    | -2 to +20                            | mA               |
| Average output current      | $I_{OA}$            | Per single pin, averaged over 100 ms  | I/O ports                                    | -2 to +20                            |                  |
|                             | $\Sigma I_{OA}$ (1) | The total current for PC0 to PC3, PD0 to PD3, and PE0 and PE1 *2              | PC0 to PC3<br>PD0 to PD3<br>PE0 and PE1      | -15 to +100                          |                  |
|                             | $\Sigma I_{OA}$ (2) | The total current for PF0 to PF3, PG0 to PG3, and PA0 to PA3 (See note 2.) *2 | PF0 to PF3<br>PG0 to PG3<br>PA0 to PA3       | -15 to +100                          |                  |
| Allowable power dissipation | Pd max (1)          | $T_a = -40$ to $+85^\circ\text{C}$ (DIP package)                              |  | 310                                  | mW               |
|                             | Pd max (2)          | $T_a = -40$ to $+85^\circ\text{C}$ (MFP package)                              |  | 220                                  |                  |
|                             | Pd max (3)          | $T_a = -40$ to $+85^\circ\text{C}$ (SSOP package)                             |  | 160                                  |                  |
| Operating temperature       | $T_{opr}$           |   |  | -40 to +85                           | $^\circ\text{C}$ |
| Storage temperature         | $T_{stg}$           |   |  | -55 to +125                          |                  |

Allowable Operating Ranges at  $T_a = -40$  to  $+85^\circ\text{C}$ ,  $V_{SS} = 0\text{ V}$ ,  $V_{DD} = 2.5$  to  $6.0\text{ V}$  (Unless otherwise specified.)

| Parameter                | Symbol       | Conditions                         | Applicable pins and notes                                      | Ratings      |     |          | Unit |
|--------------------------|--------------|------------------------------------|--|--------------|-----|----------|------|
|                          |              |                                    |  | min          | typ | max      |      |
| Operating supply voltage | $V_{DD}$     |                                    | $V_{DD}$   | 2.5          |     | 6.0      | V    |
| Standby supply voltage   | $V_{ST}$     | RAM and register values retained*3 | $V_{DD}$   | 1.8          |     | 6.0      |      |
| High-level input voltage | $V_{IH}$ (1) | Output n-channel transistors off   | Ports C, D, E, and F with open-drain specifications            | $0.7 V_{DD}$ |     | 13.5     |      |
|                          | $V_{IH}$ (2) | Output n-channel transistors off   | Ports C, D, E, and F with pull-up resistor specifications      | $0.7 V_{DD}$ |     | $V_{DD}$ |      |
|                          | $V_{IH}$ (3) | Output n-channel transistors off   | Port A, G  | $0.7 V_{DD}$ |     | $V_{DD}$ |      |
|                          | $V_{IH}$ (4) | Output n-channel transistors off   | The INT, SCK, and SI pins with open-drain specifications       | $0.8 V_{DD}$ |     | 13.5     |      |
|                          | $V_{IH}$ (5) | Output n-channel transistors off   | The INT, SCK, and SI pins with pull-up resistor specifications | $0.8 V_{DD}$ |     | $V_{DD}$ |      |
|                          | $V_{IH}$ (6) | $V_{DD} = 1.8$ to $6.0\text{ V}$   | RES  | $0.8 V_{DD}$ |     | $V_{DD}$ |      |
|                          | $V_{IH}$ (7) | External clock specifications      | OSC1   | $0.8 V_{DD}$ |     | $V_{DD}$ |      |

Continued on next page.

**LC651154N, 651154F, 651154L, 651152N, 651152F, 651152L**

Continued from preceding page.

| Parameter                                | Symbol                              | Conditions                       | Applicable pins and notes    | Ratings      |                 |                      | Unit     |
|--|-------------------------------------|----------------------------------|------------------------------|--------------|-----------------|----------------------|----------|
|  |                                     |                                  |                              | min          | typ             | max                  |          |
| Low-level input voltage                  | V <sub>IL</sub> (1)                 | Output n-channel transistors off | V <sub>DD</sub> = 4 to 6 V   | Port         | V <sub>SS</sub> | 0.3 V <sub>DD</sub>  | V        |
|  | V <sub>IL</sub> (2)                 | Output n-channel transistors off | V <sub>DD</sub> = 2.5 to 6 V | Port         | V <sub>SS</sub> | 0.2 V <sub>DD</sub>  |          |
|  | V <sub>IL</sub> (3)                 | Output n-channel transistors off | V <sub>DD</sub> = 4 to 6 V   | INT, SCK, SI | V <sub>SS</sub> | 0.25 V <sub>DD</sub> |          |
|  | V <sub>IL</sub> (4)                 | Output n-channel transistors off | V <sub>DD</sub> = 2.5 to 6 V | INT, SCK, SI | V <sub>SS</sub> | 0.15 V <sub>DD</sub> |          |
|  | V <sub>IL</sub> (5)                 | External clock specifications    | V <sub>DD</sub> = 4 to 6 V   | OSC1         | V <sub>SS</sub> | 0.25 V <sub>DD</sub> |          |
|  | V <sub>IL</sub> (6)                 | External clock specifications    | V <sub>DD</sub> = 2.5 to 6 V | OSC1         | V <sub>SS</sub> | 0.15 V <sub>DD</sub> |          |
|  | V <sub>IL</sub> (7)                 |                                  | V <sub>DD</sub> = 4 to 6 V   | TEST         | V <sub>SS</sub> | 0.3 V <sub>DD</sub>  |          |
|  | V <sub>IL</sub> (8)                 |                                  | V <sub>DD</sub> = 2.5 to 6 V | TEST         | V <sub>SS</sub> | 0.2 V <sub>DD</sub>  |          |
|  | V <sub>IL</sub> (9)                 |                                  | V <sub>DD</sub> = 4 to 6 V   | RES          | V <sub>SS</sub> | 0.25 V <sub>DD</sub> |          |
|  | V <sub>IL</sub> (10)                |                                  | V <sub>DD</sub> = 2.5 to 6 V | RES          | V <sub>SS</sub> | 0.15 V <sub>DD</sub> |          |
| Operating frequency (cycle time)         | f <sub>op</sub> (T <sub>cyc</sub> ) |                                  |                              | 200 (20)     |                 | 4330 (0.92)          | kHz (μs) |
| External clock conditions                |                                     |                                  |                              |              |                 |                      |          |
| Frequency                                | text                                | Figure 1.                        | OSC1                         | 200          |                 | 4330                 | kHz      |
| Pulse width                              | textH, textL                        |                                  | OSC1                         | 69           |                 |                      | ns       |
| Rise and fall times                      | textR, textF                        |                                  | OSC1                         |              |                 | 50                   | ns       |
| Recommended oscillator circuit constants |                                     | Figure 2                         |                              | See table 1. |                 |                      |          |
| Ceramic oscillator *4                    |                                     |                                  |                              |              |                 |                      |          |

**Electrical Characteristics at Ta = -40 to +85°C, V<sub>SS</sub> = 0 V, V<sub>DD</sub> = 2.5 to 6.0 V (Unless otherwise specified.)**

| Parameter                 | Symbol                       | Conditions  | Applicable pins and notes                                 | Ratings               |                     |                     | Unit |
|---------------------------|------------------------------|---|---|-----------------------|---------------------|---------------------|------|
|                           |                              |   |   | min                   | typ                 | max                 |      |
| High-level input current  | I <sub>IH</sub> (1)          | • Output n-channel transistors off (Including the n-channel transistor off leakage current.)<br>• V <sub>IN</sub> = 13.5 V          | Ports C, D, E and F with the open-drain specifications    |                       |                     | 5.0                 | μA   |
|                           | I <sub>IH</sub> (2)          | • Output n-channel transistors off (Including the n-channel transistor off leakage current.)<br>• V <sub>IN</sub> = V <sub>DD</sub> | Ports A and G with the open-drain specifications          |                       |                     | 1.0                 |      |
|                           | I <sub>IH</sub> (3)          | When an external clock is used, V <sub>IN</sub> = V <sub>DD</sub>   | OSC1  |                       |                     | 1.0                 |      |
| Low-level input current   | I <sub>IL</sub> (1)          | • Output n-channel transistors off<br>• V <sub>IN</sub> = V <sub>SS</sub>   | Ports with the open-drain specifications                  | -1.0                  |                     |                     | mA   |
|                           | I <sub>IL</sub> (2)          | • Output n-channel transistors off<br>• V <sub>IN</sub> = V <sub>SS</sub>   | Ports with the pull-up resistor specifications            | -1.3                  | -0.35               |                     |      |
|                           | I <sub>IL</sub> (3)          | V <sub>IN</sub> = V <sub>SS</sub>   | RES   | -45                   | -10                 |                     | μA   |
|                           | I <sub>IL</sub> (4)          | When an external clock is used, V <sub>IN</sub> = V <sub>SS</sub>   | OSC1  | -1.0                  |                     |                     |      |
| High-level output voltage | V <sub>OH</sub> (1)          | • I <sub>OH</sub> = -50 μA<br>• V <sub>DD</sub> = 4.0 to 6.0 V  | Ports with the pull-up resistor specifications            | V <sub>DD</sub> - 1.2 |                     |                     | V    |
|                           | V <sub>OH</sub> (2)          | I <sub>OH</sub> = -10 μA  | Ports with the pull-up resistor specifications            | V <sub>DD</sub> - 0.5 |                     |                     |      |
| Low-level output voltage  | V <sub>OL</sub> (1)          | • I <sub>OL</sub> = 10 mA<br>• V <sub>DD</sub> = 4.0 to 6.0 V   | Port  |                       |                     | 1.5                 |      |
|                           | V <sub>OL</sub> (2)          | When I <sub>OL</sub> = 1 mA and the I <sub>OL</sub> for each port is 1 mA or less.  | Port  |                       |                     | 0.5                 |      |
| Schmitt characteristics   | Hysteresis voltage           | V <sub>HIS</sub>  | RES, INT, SCK, SI, and OSC1 with Schmitt specifications*5 |                       | 0.1 V <sub>DD</sub> |                     |      |
|                           | High-level threshold voltage | V <sub>TH</sub>   |   | 0.4 V <sub>DD</sub>   |                     | 0.8 V <sub>DD</sub> |      |
|                           | Low-level threshold voltage  | V <sub>TL</sub>   |   | 0.25 V <sub>DD</sub>  |                     | 0.6 V <sub>DD</sub> |      |

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**LC651154N, 651154F, 651154L, 651152N, 651152F, 651152L**

Continued from preceding page.

| Parameter   | Symbol                | Conditions   | Applicable pins and notes               | Ratings |                            |         | Unit |
|---|-----------------------|--|---|---------|----------------------------|---------|------|
|   |                       |  |   | min     | typ                        | max     |      |
| Current drain*6<br><br>Ceramic oscillator<br><br>Standby mode | IDDOP (1)             | <ul style="list-style-type: none"> <li>Figure 2, 4 MHz</li> <li>200 kHz to 4330 kHz</li> </ul>   | V <sub>DD</sub>                         |         | 2                          | 6       | mA   |
|   | IDDOP (2)             |  | V <sub>DD</sub>                         |         | 2                          | 6       |      |
|   | IDDst                 | <ul style="list-style-type: none"> <li>Output n-channel transistors off</li> <li>V<sub>DD</sub> = 6 V</li> <li>Ports at V<sub>DD</sub>, V<sub>DD</sub> = 2.5 V</li> </ul>  | V <sub>DD</sub><br>V <sub>DD</sub>      |         | 0.05<br>0.025              | 10<br>5 | μA   |
| Oscillator characteristics<br>Ceramic oscillator              | f <sub>CFOSC</sub> *7 | <ul style="list-style-type: none"> <li>Figure 2, fo = 4 MHz</li> </ul>   | OSC1, OSC2                              | 3920    | 4000                       | 4080    | kHz  |
| Oscillator frequency*8  | t <sub>CFS</sub>      | <ul style="list-style-type: none"> <li>Figure 3, fo = 4 MHz</li> </ul>   |   |         |                            | 10      | ms   |
| Pull-up resistor<br>I/O ports                                 | RPP                   | <ul style="list-style-type: none"> <li>Output n-channel transistors off</li> <li>V<sub>IN</sub> = V<sub>SS</sub>, V<sub>DD</sub> = 5 V</li> </ul>  | Pull-up resistor<br>specification ports | 8       | 14                         | 30      | kΩ   |
|   | RES                   | V <sub>IN</sub> = V <sub>SS</sub> , V <sub>DD</sub> = 5 V  | RES                                     | 200     | 500                        | 800     |      |
| External reset characteristics<br>Reset time                  | t <sub>RST</sub>      |  |   |         | See figure 4.              |         |      |
| Pin capacitances  | Cp                    | <ul style="list-style-type: none"> <li>f = 1 MHz</li> <li>With all pins other than the pin being tested at V<sub>IN</sub> = V<sub>SS</sub>.</li> </ul>   |   |         | 10                         |         | pF   |
| Serial clock  | t <sub>CKCY</sub> (1) | Figure 5   | SCK                                     | 2.0     |                            |         | μs   |
| Input clock cycle time  | t <sub>CKCY</sub> (2) | Figure 5   | SCK                                     |         | 64 × T <sub>CYC</sub> *9   |         |      |
| Output clock cycle time                                       | t <sub>CKL</sub> (1)  | Figure 5   | SCK                                     | 0.6     |                            |         |      |
| Input clock low-level pulse width                             | t <sub>CKL</sub> (2)  | Figure 5   | SCK                                     |         | 32 × T <sub>CYC</sub>      |         |      |
| Output clock low-level pulse width                            | t <sub>CKH</sub> (1)  | Figure 5   | SCK                                     | 0.6     |                            |         |      |
| Input clock high-level pulse width                            | t <sub>CKH</sub> (2)  | Figure 5   | SCK                                     |         | 32 × T <sub>CYC</sub>      |         |      |
| Output clock high-level pulse width                           |                       |  |   |         |                            |         |      |
| Serial input  |                       |  |   |         |                            |         |      |
| Data setup time   | t <sub>ICK</sub>      | <ul style="list-style-type: none"> <li>Stipulated with respect to the rising edge of SCK.</li> <li>Figure 5</li> </ul>   | SI                                      | 0.2     |                            |         |      |
| Data hold time  | t <sub>ICKI</sub>     |  | SI                                      | 0.2     |                            |         |      |
| Serial output   |                       |  |   |         |                            |         | μs   |
| Output delay time   | t <sub>CKO</sub>      | <ul style="list-style-type: none"> <li>Stipulated with respect to the falling edge of SCK.</li> <li>With an external resistor of 1 kΩ and an external capacitor of 50 pF on only the n-channel open-drain pins.</li> <li>Figure 5</li> </ul> | SO                                      |         |                            | 0.4     |      |
| Pulse output function<br>Period                               | t <sub>PCY</sub>      | <ul style="list-style-type: none"> <li>Figure 6</li> <li>T<sub>CYC</sub> = 4 × system clock period</li> </ul>  | PE0                                     |         | 64 × T <sub>CYC</sub>      |         |      |
| High-level pulse width  | t <sub>PH</sub>       | <ul style="list-style-type: none"> <li>With an external resistor of 1 kΩ and an external capacitor of 50 pF on only the n-channel open-drain pins.</li> </ul>  | PE0                                     |         | 32 × T <sub>CYC</sub> ±10% |         |      |
| Low-level pulse width   | t <sub>PL</sub>       |  | PE0                                     |         | 32 × T <sub>CYC</sub> ±10% |         |      |

Continued on next page.

**LC651154N, 651154F, 651154L, 651152N, 651152F, 651152L**

Continued from preceding page.

| Parameter                     | Symbol                        | Conditions      |  | Applicable pins and notes              | Ratings   |  |                                       | Unit             |
|-------------------------------|-------------------------------|-----------------|--|--|---|--|---------------------------------------|------------------|
|                               |                               |                 |  |  | min   | typ                                    | max                                   |                  |
| A/D converter characteristics | Resolution                    |                 |  | $V_{DD} = 3 \text{ to } 6 \text{ V}$   |   | 8                                      |                                       | bit              |
|                               | Absolute precision            | $AV_+ = V_{DD}$ | A/D converter speed 1/1  | $V_{DD} = 3.5 \text{ to } 6 \text{ V}$ |   | $\pm 1$                                | $\pm 2$                               | LSB              |
|                               |                               | $AV_- = V_{SS}$ | A/D converter speed 1/2  | $V_{DD} = 3.5 \text{ to } 6 \text{ V}$ |   | $\pm 1$                                | $\pm 2$                               |                  |
|                               | Conversion time               | TCAD            | When the A/D converter speed is normal (1/1), namely $26 \times T_{CYC}$   | $V_{DD} = 3.5 \text{ to } 6 \text{ V}$ |   | 24<br>( $T_{CYC} = 0.92 \mu\text{s}$ ) | 312<br>( $T_{CYC} = 12 \mu\text{s}$ ) | $\mu\text{s}$    |
|                               |                               |                 | When the A/D converter speed is one half (1/2), namely $51 \times T_{CYC}$ | $V_{DD} = 3 \text{ to } 6 \text{ V}$   |   | 47<br>( $T_{CYC} = 0.92 \mu\text{s}$ ) | 612<br>( $T_{CYC} = 12 \mu\text{s}$ ) |                  |
|                               | Input reference voltage       | $AV_+$          |  | $V_{DD} = 3 \text{ to } 6 \text{ V}$   | $AV_+$  | $AV_-$                                 | $V_{DD}$                              | V                |
|                               |                               | $AV_-$          |  |  | $AV_-$  | $V_{SS}$                               | $AV_+$                                |                  |
|                               | Input reference current range | IRIF            | $AV_+ = V_{DD}, AV_- = V_{SS}$   |  | $AV_+, AV_-$  | 200                                    | 500                                   | $\mu\text{A}$    |
|                               | Analog input voltage range    | VAIN            |  |  | AD0 to AD7  | $AV_-$                                 | $AV_+$                                | V                |
|                               | Analog port input current     | IAIN            | Including the output off leakage current.<br>$V_{AIN} = V_{DD}$            |  | AD0 to AD7<br>(The I/O shared function ports have open-drain specifications.) |  | 1                                     | $\mu\text{A}$    |
|                               |                               |                 | $V_{AIN} = V_{SS}$   |  |   | -1                                     |                                       |                  |
| Watchdog timer                | Recommended constants*10      | Cw              | When PE1 has the open drain specifications.                                | WDR                                    |   | $0.01 \pm 5\%$                         |                                       | $\mu\text{F}$    |
|                               |                               | Rw              | When PE1 has the open drain specifications.                                | WDR                                    |   | $680 \pm 1\%$                          |                                       | $\text{k}\Omega$ |
|                               |                               | RI              | When PE1 has the open drain specifications.                                | WDR                                    |   | $100 \pm 1\%$                          |                                       | $\Omega$         |
|                               | Clear time (discharge)        | $t_{WCT}$       | Figure 7   | WDR                                    | 10  |  |                                       | $\mu\text{s}$    |
|                               | Clear period (charge)         | $t_{WCCY}$      | Figure 7   | WDR                                    | 4.2   |  |                                       | ms               |

- Notes: 1. Allowed up to the amplitude generated when the oscillator shown in figure 2 is used with the recommended circuit constants and driven by the IC.  
2. The average over a 100 ms period.  
3. The operating  $V_{DD}$  supply voltage must be maintained from the point the HALT instruction is executed until the IC has fully entered the standby state. Applications must also assure that no chattering occurs on the PA3 pin during the HALT instruction execution cycle.  
4. Recommended circuit constants that have been verified to oscillate stably according to the oscillator element manufacturer using the Sanyo-stipulated oscillator characteristics evaluation board.  
5. The OSC1 pin will have Schmitt characteristics when external clock oscillator is selected with the two-pin RC oscillator option.  
6. These are the results of testing using our (Sanyo's) characteristics evaluation board with the recommended circuit constants used as external components. The current flowing in the IC's output transistors and transistors that have pull-up resistors is not included.  
7.  $f_{CFOSC}$  is the frequency when the recommended circuit constants from table 1 are used as external components.  
8. Indicates the time required to achieve stable oscillation from the point  $V_{DD}$  rises above the lower limit of the operating voltage range (See figure 3).  
9.  $T_{CYC} = 4 \times$  the system clock period  
10. If the application could be used in an environment in which condensation is possible, extra care with respect to the leakage between PE1 and adjacent pins and leakage associated with external resistors and capacitor is required during design.



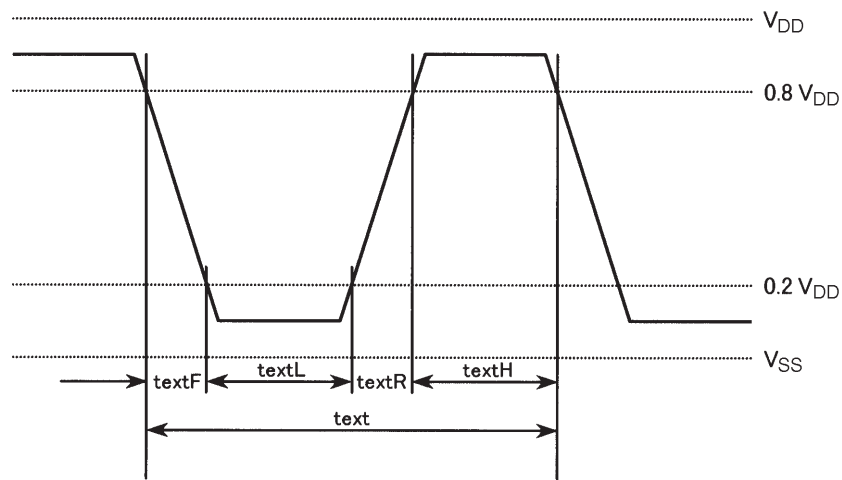
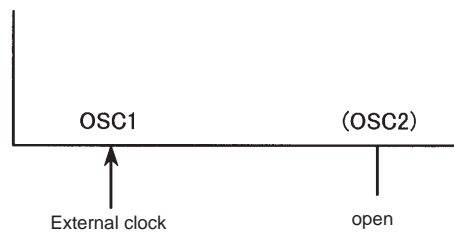


Figure 1 External Clock Input Waveform

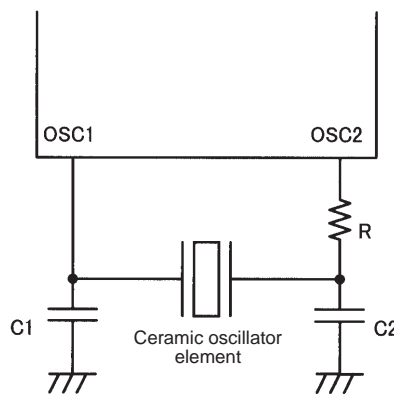


Figure 2 Ceramic Oscillator Circuit

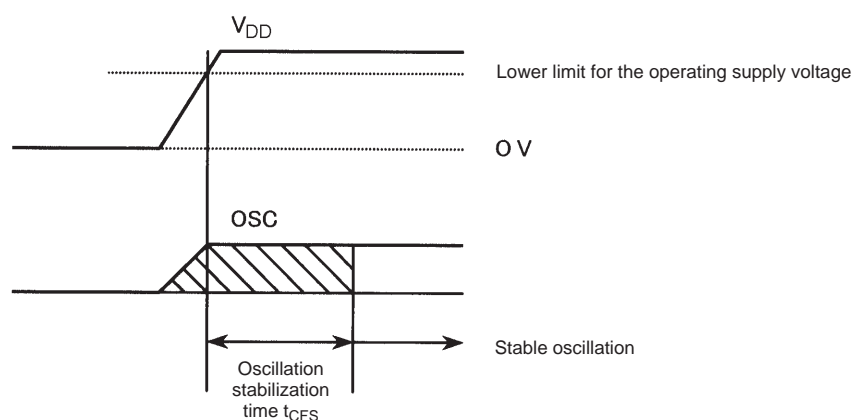


Figure 4 Oscillation Stabilization Time

Table 1 Recommended Ceramic Oscillator Circuit Constants

|                                 |    |                  |
|---------------------------------|----|------------------|
| 4 MHz (Murata Mfg. Co., Ltd.)   | C1 | 33 pF $\pm 10\%$ |
| CSA4.00MG                       | C2 | 33 pF $\pm 10\%$ |
| CST4.00MGW (Internal capacitor) | R  | 0 $\Omega$       |
| 4 MHz (Kyocera Corporation)     | C1 | 33 pF $\pm 10\%$ |
| KBR4.0MSA                       | C2 | 33 pF $\pm 10\%$ |
| KBR4.0MKS (Internal capacitor)  | R  | 0 $\Omega$       |

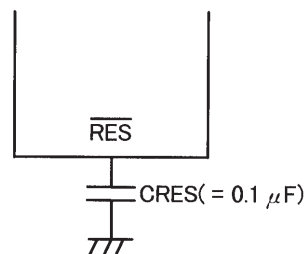


Figure 5 Reset Circuit

Note: If the power supply rise time is zero, the reset time when  $C_{RES} = 0.1 \mu F$  will be between 10 and 100 ms.  
If the power supply rise time is long, increase the value of  $C_{RES}$  so that the reset time is at least 10 ms.

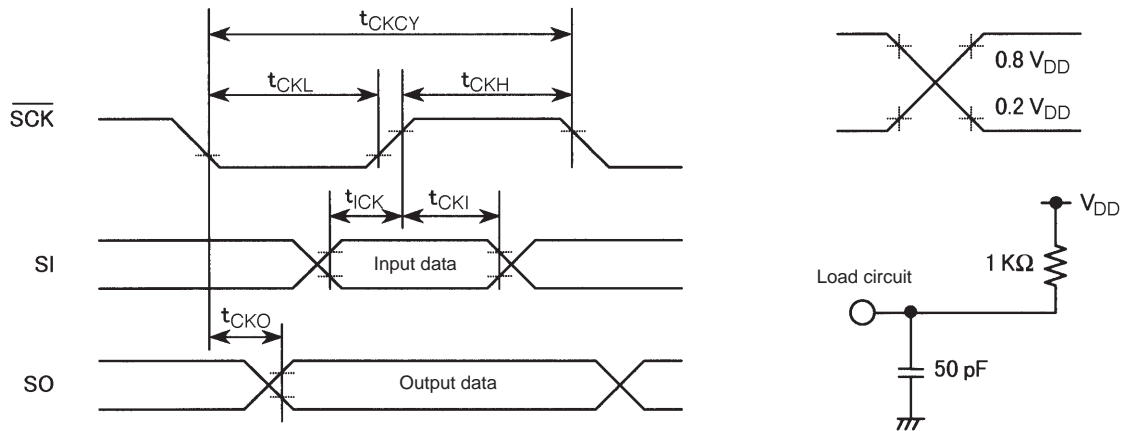


Figure 5 Serial I/O Timing

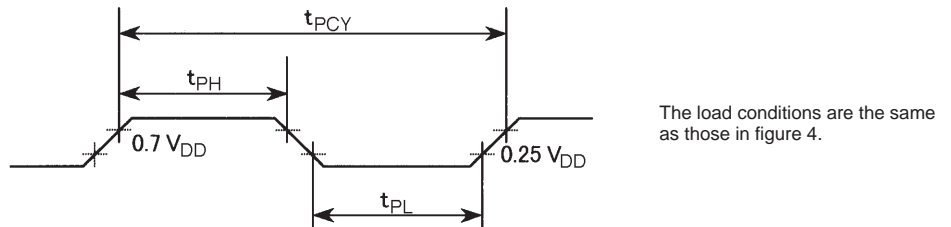
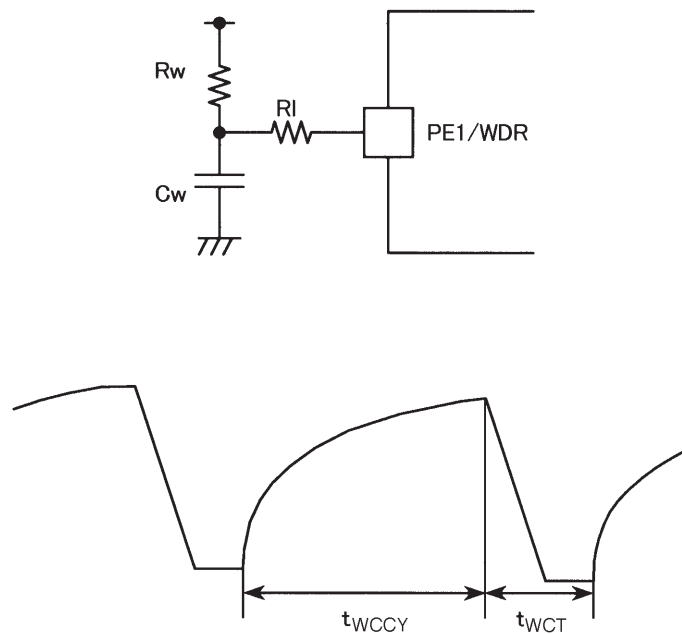


Figure 6 Port PE0 Pulse Output Timing



$t_{WCCY}$ : The charge time due to the time constant of the circuit consisting of the external components  $C_w$ ,  $R_w$ , and  $R_I$ .  
 $t_{WCT}$ : The discharge time due to software processing.

Figure 7 Watchdog Timer Waveform

## LC651154L, 651152L

Absolute Maximum Ratings at  $T_a = 25^\circ\text{C}$ ,  $V_{SS} = 0\text{ V}$ 

| Parameter                   | Symbol               | Conditions  | Applicable pins and notes                                     | Ratings                              | Unit             |
|-----------------------------|----------------------|---|---|--------------------------------------|------------------|
| Maximum supply voltage      | $V_{DD\text{ max}}$  |   | $V_{DD}$  | -0.3 to +7.0                         | V                |
| Output voltage              | $V_O$                |   | OSC2  | Allowed up to the generated voltage. |                  |
| Input voltage               | $V_I$ (1)            |   | OSC1 *1   | -0.3 to $V_{DD} + 0.3$               |                  |
|                             | $V_I$ (2)            |   | TEST, $\overline{\text{RES}}$ , $\text{AV}_+$ , $\text{AV}_-$ | -0.3 to $V_{DD} + 0.3$               |                  |
| I/O voltage                 | $V_{IO}$ (1)         | PC0 to PC3, PD0 to PD3, PE0, 1, PF0 to PF3                                    | Open-drain specification ports                                | -0.3 to +15                          |                  |
|                             | $V_{IO}$ (2)         | PC0 to PC3, PD0 to PD3, PE0, 1, PF0 to PF3                                    | Pull-up resistor specification ports                          | -0.3 to $V_{DD} + 0.3$               |                  |
|                             | $V_{IO}$ (3)         | PA0 to PA3, PG0 to PG3  |   | -0.3 $V_{DD} + 0.3$                  |                  |
| Peak output current         | $I_{OP}$             |   | I/O ports   | -2 to +20                            | mA               |
| Average output current      | $I_{OA}$             | Per single pin, averaged over 100 ms  | I/O ports   | -2 to +20                            |                  |
|                             | $\Sigma I_{OA}$ (1)  | The total current for PC0 to PC3, PD0 to PD3, and PE0 to PE1 *2               | PC0 to PC3<br>PD0 to PD3<br>PE0 to PE1                        | -15 to +100                          |                  |
|                             | $\Sigma I_{OA}$ (2)  | The total current for PF0 to PF3, PG0 to PG3, and PA0 to PA3 (See note 2.) *2 | PF0 to PF3<br>PG0 to PG3<br>PA0 to PA3                        | -15 to +100                          |                  |
| Allowable power dissipation | $P_d\text{ max}$ (1) | $T_a = -40$ to $+85^\circ\text{C}$ (DIP package)                              |   | 310                                  | mW               |
|                             | $P_d\text{ max}$ (2) | $T_a = -40$ to $+85^\circ\text{C}$ (MFP package)                              |   | 220                                  |                  |
|                             | $P_d\text{ max}$ (3) | $T_a = -40$ to $+85^\circ\text{C}$ (SSOP package)                             |   | 160                                  |                  |
| Operating temperature       | $T_{opr}$            |   |   | -40 to +85                           | $^\circ\text{C}$ |
| Storage temperature         | $T_{stg}$            |   |   | -55 to +125                          |                  |

Allowable Operating Ranges at  $T_a = -40$  to  $+85^\circ\text{C}$ ,  $V_{SS} = 0\text{ V}$ ,  $V_{DD} = 2.2$  to  $6.0\text{ V}$  (Unless otherwise specified.)

| Parameter                | Symbol       | Conditions                         | Applicable pins and notes  | Ratings      |     |               | Unit |
|--------------------------|--------------|------------------------------------|--|--------------|-----|---------------|------|
|                          |              |                                    |  | min          | typ | max           |      |
| Operating supply voltage | $V_{DD}$     |                                    | $V_{DD}$   | 2.2          |     | 6.0           | V    |
| Standby supply voltage   | $V_{ST}$     | RAM and register values retained*3 | $V_{DD}$   | 1.8          |     | 6.0           |      |
| High-level input voltage | $V_{IH}$ (1) | Output n-channel transistors off   | Ports C, D, E, and F with open-drain specifications  | $0.7 V_{DD}$ |     | 13.5          |      |
|                          | $V_{IH}$ (2) | Output n-channel transistors off   | Ports C, D, E, and F with pull-up resistor specifications  | $0.7 V_{DD}$ |     | $V_{DD}$      |      |
|                          | $V_{IH}$ (3) | Output n-channel transistors off   | Port A, G  | $0.7 V_{DD}$ |     | $V_{DD}$      |      |
|                          | $V_{IH}$ (4) | Output n-channel transistors off   | The $\overline{\text{INT}}$ , $\overline{\text{SCK}}$ , and SI pins with open-drain specifications       | $0.8 V_{DD}$ |     | 13.5          |      |
|                          | $V_{IH}$ (5) | Output n-channel transistors off   | The $\overline{\text{INT}}$ , $\overline{\text{SCK}}$ , and SI pins with pull-up resistor specifications | $0.8 V_{DD}$ |     | $V_{DD}$      |      |
|                          | $V_{IH}$ (6) | $V_{DD} = 1.8$ to $6.0\text{ V}$   | $\overline{\text{RES}}$  | $0.8 V_{DD}$ |     | $V_{DD}$      |      |
|                          | $V_{IH}$ (7) | External clock specifications      | OSC1   | $0.8 V_{DD}$ |     | $V_{DD}$      |      |
| Low-level input voltage  | $V_{IL}$ (1) | Output n-channel transistors off   | Port   | $V_{SS}$     |     | $0.2 V_{DD}$  |      |
|                          | $V_{IL}$ (2) | Output n-channel transistors off   | $\overline{\text{INT}}$ , $\overline{\text{SCK}}$ , SI   | $V_{SS}$     |     | $0.15 V_{DD}$ |      |
|                          | $V_{IL}$ (3) | Output n-channel transistors off   | OSC1   | $V_{SS}$     |     | $0.15 V_{DD}$ |      |
|                          | $V_{IL}$ (4) |                                    | TEST   | $V_{SS}$     |     | $0.2 V_{DD}$  |      |
|                          | $V_{IL}$ (5) |                                    | $\overline{\text{RES}}$  | $V_{SS}$     |     | $0.15 V_{DD}$ |      |

Continued on next page.

**LC651154N, 651154F, 651154L, 651152N, 651152F, 651152L**

Continued from preceding page.

| Parameter                                | Symbol       | Conditions   | Applicable pins and notes | Ratings           |     |                | Unit     |
|--|--------------|--|---------------------------|-------------------|-----|----------------|----------|
|  |              |  |                           | min               | typ | max            |          |
| Operating frequency (cycle time)         | fop (Tcyc)   | The clock may have a frequency up to 4.16 MHz when the divide-by-four internal divider circuit option is used.               |                           | 200<br>(20)       |     | 1040<br>(3.84) | kHz (μs) |
| External clock conditions                |              | Figure 1.  |                           |                   |     |                |          |
| Frequency                                | text         | Either the divide-by-three or divide-by-four internal divider circuit must be used if the clock frequency exceeds 1.040 MHz. | OSC1                      | 200               |     | 4160           | kHz      |
| Pulse width                              | textH, textL |  | OSC1                      | 100               |     |                | ns       |
| Rise and fall times                      | textR, textF |  | OSC1                      |                   |     | 100            | ns       |
| Recommended oscillator circuit constants |              |  |                           |                   |     |                |          |
| Two-pin RC oscillator                    | Cext<br>Rext | Figure 2   | OSC1, OSC2                | 270 ±5%<br>12 ±1% |     |                | pF<br>kΩ |
| Ceramic oscillator *4                    |              | Figure 3   |                           | See table 1.      |     |                |          |

**LC651154N, 651154F, 651154L, 651152N, 651152F, 651152L**

**Electrical Characteristics at Ta = –40 to +85°C, V<sub>SS</sub> = 0 V, V<sub>DD</sub> = 2.2 to 6.0 V (Unless otherwise specified.)**

| Parameter                 | Symbol                       | Conditions   | Applicable pins and notes                                 | Ratings               |                     |                     | Unit |
|---------------------------|------------------------------|--|---|-----------------------|---------------------|---------------------|------|
|                           |                              |  |   | min                   | typ                 | max                 |      |
| High-level input current  | I <sub>IH</sub> (1)          | • Output n-channel transistors off (Including the n-channel transistor off leakage current.)<br>• V <sub>IN</sub> = 13.5 V                             | Ports C, D, E and F with the open-drain specifications    |                       |                     | 5.0                 | μA   |
|                           | I <sub>IH</sub> (2)          | • Output n-channel transistors off (Including the n-channel transistor off leakage current.)<br>• V <sub>IN</sub> = V <sub>DD</sub>                    | Ports A and G with the open-drain specifications          |                       |                     | 1.0                 |      |
|                           | I <sub>IH</sub> (3)          | When an external clock is used, V <sub>IN</sub> = V <sub>DD</sub>  | OSC1  |                       |                     | 1.0                 |      |
| Low-level input current   | I <sub>IL</sub> (1)          | • Output n-channel transistors off<br>• V <sub>IN</sub> = V <sub>SS</sub>  | Ports with the open-drain specifications                  | –1.0                  |                     |                     | mA   |
|                           | I <sub>IL</sub> (2)          | • Output n-channel transistors off<br>• V <sub>IN</sub> = V <sub>SS</sub>  | Ports with the pull-up resistor specifications            | –1.3                  | –0.35               |                     |      |
|                           | I <sub>IL</sub> (3)          | V <sub>IN</sub> = V <sub>SS</sub>  | RES   | –45                   | –10                 |                     | μA   |
|                           | I <sub>IL</sub> (4)          | When an external clock is used, V <sub>IN</sub> = V <sub>SS</sub>  | OSC1  | –1.0                  |                     |                     |      |
| High-level output voltage | V <sub>OH</sub>              | • I <sub>OH</sub> = –10 μA   | Ports with the pull-up resistor specifications            | V <sub>DD</sub> – 0.5 |                     |                     | V    |
| Low-level output voltage  | V <sub>OL</sub> (1)          | • I <sub>OL</sub> = 3 mA   | Port  |                       |                     | 1.5                 |      |
|                           | V <sub>OL</sub> (2)          | When I <sub>OL</sub> = 1 mA and the I <sub>OL</sub> for each port is 1 mA or less.   | Port  |                       |                     | 0.4                 |      |
| Schmitt characteristics   | Hysteresis voltage           |  | RES, INT, SCK, SI, and OSC1 with Schmitt specifications*5 |                       | 0.1 V <sub>DD</sub> |                     |      |
|                           | High-level threshold voltage |  |   | 0.4 V <sub>DD</sub>   |                     | 0.8 V <sub>DD</sub> |      |
|                           | Low-level threshold voltage  |  |   | 0.2 V <sub>DD</sub>   |                     | 0.6 V <sub>DD</sub> |      |
| Current drain *6          |                              |  |   |                       |                     |                     | mA   |
| Two-pin RC oscillator     | IDDOP (1)                    | • Operating, with the output n-channel transistors off<br>• With the ports at V <sub>DD</sub><br>• Figure 2, fosc = 800 kHz (typical)                  | V <sub>DD</sub>   |                       | 1.0                 | 4                   |      |
| Ceramic oscillator        | IDDOP (2)                    | • Figure 3, 4 MHz, divide-by-four circuit used   | V <sub>DD</sub>   |                       | 1.5                 | 4                   |      |
|                           | IDDOP (3)                    | • Figure 3, 4 MHz, divide-by-four circuit used<br>V <sub>DD</sub> = 2.2 V  | V <sub>DD</sub>   |                       | 0.5                 | 1                   |      |
|                           | IDDOP (4)                    | • Figure 3, 400 kHz  | V <sub>DD</sub>   |                       | 1.0                 | 2.5                 |      |
|                           | IDDOP (5)                    | • Figure 3, 800 kHz  | V <sub>DD</sub>   |                       | 1.5                 | 4                   |      |
|                           | IDDOP (6)                    | • 200 kHz to 1024 kHz, no divider circuit<br>• 600 kHz to 3120 kHz, divide-by-three circuit used<br>• 800 kHz to 4160 kHz, divide-by-four circuit used | V <sub>DD</sub>   |                       | 1.5                 | 4                   |      |
| Standby mode              | IDDst                        | Output n-channel transistors off, V <sub>DD</sub> = 6 V<br>Ports at V <sub>DD</sub> , V <sub>DD</sub> = 2.2 V  | V <sub>DD</sub><br>V <sub>DD</sub>                        |                       | 0.05<br>0.020       | 10<br>4             | μA   |

Continued on next page.

**LC651154N, 651154F, 651154L, 651152N, 651152F, 651152L**

Continued from preceding page.

| Parameter                                   | Symbol                  | Conditions  | Applicable pins and notes                            | Ratings                   |                                     |                            | Unit          |
|---|-------------------------|---|--|---------------------------|-------------------------------------|----------------------------|---------------|
|   |                         |   |  | min                       | typ                                 | max                        |               |
| Oscillator characteristics                  |                         |   |  |                           |                                     |                            |               |
| Ceramic oscillator                          |                         |   |  |                           |                                     |                            |               |
| Oscillator frequency                        | $f_{\text{CFOSC}}^{*7}$ | <ul style="list-style-type: none"> <li>Figure 3, <math>f_o = 400</math> kHz</li> <li>Figure 3, <math>f_o = 800</math> kHz</li> <li>Figure 3, <math>f_o = 1</math> MHz</li> <li>Figure 3, <math>f_o = 4</math> MHz, with the divide-by-four circuit used.</li> </ul> | OSC1, OSC2<br>OSC1, OSC2<br>OSC1, OSC2<br>OSC1, OSC2 | 392<br>784<br>980<br>3920 | 400<br>800<br>1000<br>4000          | 408<br>816<br>1020<br>4080 | kHz           |
| Oscillator stabilization time <sup>*8</sup> | $t_{\text{CFS}}$        | <ul style="list-style-type: none"> <li>Figure 4, <math>f_o = 400</math> kHz</li> <li>Figure 4, <math>f_o = 800</math> kHz, 1 MHz, or 4 MHz, with the divide-by-four circuit used.</li> </ul>  |  |                           |                                     | 10<br>10                   | ms            |
| Two-pin RC oscillator                       |                         |   |  |                           |                                     |                            |               |
| Oscillator frequency                        | $f_{\text{MOSC}}$       | <ul style="list-style-type: none"> <li>Figure 2, <math>C_{\text{ext}} = 270</math> pF <math>\pm 5\%</math></li> <li>Figure 2, <math>R_{\text{ext}} = 5.6</math> k<math>\Omega</math> <math>\pm 1\%</math></li> </ul>  | OSC1, OSC2   | 290                       | 400                                 | 841                        | kHz           |
| Pull-up resistor                            |                         |   |  |                           |                                     |                            |               |
| I/O ports                                   | RPP                     | <ul style="list-style-type: none"> <li>Output n-channel transistors off</li> <li><math>V_{\text{IN}} = V_{\text{SS}}</math>, <math>V_{\text{DD}} = 5</math> V</li> </ul>  | Pull-up resistor specification ports                 | 8                         | 14                                  | 30                         | k $\Omega$    |
| RES   | Ru                      | $V_{\text{IN}} = V_{\text{SS}}$ , $V_{\text{DD}} = 5$ V   | RES  | 200                       | 500                                 | 800                        |               |
| External reset characteristics              |                         |   |  |                           |                                     |                            |               |
| Reset time                                  | $t_{\text{RST}}$        |   |  |                           | See figure 5.                       |                            |               |
| Pin capacitances                            | $C_p$                   | <ul style="list-style-type: none"> <li><math>f = 1</math> MHz</li> <li>With all pins other than the pin being tested at <math>V_{\text{IN}} = V_{\text{SS}}</math>.</li> </ul>  |  |                           | 10                                  |                            | pF            |
| Serial clock                                |                         |   |  |                           |                                     |                            |               |
| Input clock cycle time                      | $t_{\text{CKCY}} (1)$   | Figure 6  | $\overline{\text{SCK}}$                              | 2.0                       |                                     |                            | $\mu\text{s}$ |
| Output clock cycle time                     | $t_{\text{CKCY}} (2)$   | Figure 6  | $\overline{\text{SCK}}$                              |                           | $64 \times T_{\text{CYC}}^{*9}$     |                            |               |
| Input clock low-level pulse width           | $t_{\text{CKL}} (1)$    | Figure 6  | $\overline{\text{SCK}}$                              | 2.0                       |                                     |                            |               |
| Output clock low-level pulse width          | $t_{\text{CKL}} (2)$    | Figure 6  | $\overline{\text{SCK}}$                              |                           | $32 \times T_{\text{CYC}}$          |                            |               |
| Input clock high-level pulse width          | $t_{\text{CKH}} (1)$    | Figure 6  | $\overline{\text{SCK}}$                              | 2.0                       |                                     |                            |               |
| Output clock high-level pulse width         | $t_{\text{CKH}} (2)$    | Figure 6  | $\overline{\text{SCK}}$                              |                           | $32 \times T_{\text{CYC}}$          |                            |               |
| Serial input                                |                         |   |  |                           |                                     |                            |               |
| Data setup time                             | $t_{\text{ICK}}$        | <ul style="list-style-type: none"> <li>Stipulated with respect to the rising edge of SCK.</li> <li>Figure 6</li> </ul>  | SI   | 0.5                       |                                     |                            | $\mu\text{s}$ |
| Data hold time                              | $t_{\text{ICKI}}$       |   | SI   | 0.5                       |                                     |                            |               |
| Serial output                               |                         |   |  |                           |                                     |                            |               |
| Output delay time                           | $t_{\text{CKO}}$        | <ul style="list-style-type: none"> <li>Stipulated with respect to the falling edge of SCK.</li> <li>With an external resistor of 1 k<math>\Omega</math> and an external capacitor of 50 pF on only the n-channel open-drain pins.</li> <li>Figure 6</li> </ul>      | SO   |                           |                                     | 1.0                        |               |
| Pulse output function                       |                         |   |  |                           |                                     |                            |               |
| Period                                      | $t_{\text{PCY}}$        | <ul style="list-style-type: none"> <li>Figure 7</li> <li><math>T_{\text{CYC}} = 4 \times</math> system clock period</li> </ul>  | PE0  |                           | $64 \times T_{\text{CYC}}$          |                            |               |
| High-level pulse width                      | $t_{\text{PH}}$         | <ul style="list-style-type: none"> <li>With an external resistor of 1 k<math>\Omega</math> and an external capacitor of 50 pF on only the n-channel open-drain pins.</li> </ul>   | PE0  |                           | $32 \times T_{\text{CYC}} \pm 10\%$ |                            |               |
| Low-level pulse width                       | $t_{\text{PL}}$         |   | PE0  |                           | $32 \times T_{\text{CYC}} \pm 10\%$ |                            |               |

Continued on next page.

Continued from preceding page.

| Parameter                     |                               | Symbol            | Conditions  | Applicable pins and notes   | Ratings                             |     |                                   | Unit |    |
|-------------------------------|-------------------------------|-------------------|---|---|-------------------------------------|-----|-----------------------------------|------|----|
|                               |                               |                   |   |   | min                                 | typ | max                               |      |    |
| A/D converter characteristics | Resolution                    |                   |   |   |                                     | 8   |                                   | bit  |    |
|                               | Absolute precision            |                   | AV <sub>+</sub> = V <sub>DD</sub><br>AV <sub>-</sub> = V <sub>SS</sub>          |   |                                     | ±1  | ±2                                | LSB  |    |
|                               | Conversion time               | TCAD              | When the A/D converter speed is normal (1/1), namely 26 × T <sub>CYC</sub>      |   | 99<br>(T <sub>CYC</sub> = 3.84 μs)  |     | 312<br>(T <sub>CYC</sub> = 12 μs) | μs   |    |
|                               |                               |                   | When the A/D converter speed is one half (1/2), namely 51 × T <sub>CYC</sub>    |   | 195<br>(T <sub>CYC</sub> = 3.84 μs) |     | 612<br>(T <sub>CYC</sub> = 12 μs) |      |    |
|                               | Input reference voltage       | AV <sub>+</sub>   |   | AV <sub>+</sub>   | AV <sub>-</sub>                     |     | V <sub>DD</sub>                   | V    |    |
|                               |                               | AV <sub>-</sub>   |   | AV <sub>-</sub>   | V <sub>SS</sub>                     |     | AV <sub>+</sub>                   |      |    |
|                               | Input reference current range | I <sub>RIF</sub>  | AV <sub>+</sub> = V <sub>DD</sub><br>AV <sub>-</sub> = V <sub>SS</sub>          | AV <sub>+</sub> , AV <sub>-</sub>   | 200                                 | 500 | 800                               | μA   |    |
|                               | Analog input voltage range    | V <sub>AIN</sub>  |   | AD0 to AD7  | AV <sub>-</sub>                     |     | AV <sub>+</sub>                   | V    |    |
|                               | Analog port input current     | I <sub>AIN</sub>  | Including the output off leakage current.<br>V <sub>AIN</sub> = V <sub>DD</sub> | AD0 to AD7<br>(The I/O shared function ports have open-drain specifications.) |                                     |     |                                   | 1    | μA |
|                               |                               |                   | V <sub>AIN</sub> = V <sub>SS</sub>  |   | -1                                  |     |                                   |      |    |
| Watchdog timer                | Recommended constants*10      | Cw                | When PE1 has the open-drain specifications.                                     | V <sub>DD</sub> = 2.2 to 6 V  | WDR                                 |     | 0.1 ±5%                           |      | μF |
|                               |                               | Rw                | When PE1 has the open-drain specifications.                                     |   | WDR                                 |     | 680 ±1%                           |      | kΩ |
|                               |                               | RI                | When PE1 has the open-drain specifications.                                     |   | WDR                                 |     | 100 ±1%                           |      | Ω  |
|                               | Clear time (discharge)        | t <sub>WCT</sub>  | Figure 8  |   | WDR                                 | 100 |                                   | μs   |    |
|                               | Clear period (charge)         | t <sub>WCCY</sub> | Figure 8  |   | WDR                                 | 31  |                                   | ms   |    |
|                               | Recommended constants*10      | Cw                | When PE1 has the open-drain specifications.                                     | V <sub>DD</sub> = 2.2 to 6 V  | WDR                                 |     | 0.047 ±5%                         |      | μF |
|                               |                               | Rw                | When PE1 has the open-drain specifications.                                     |   | WDR                                 |     | 680 ±1%                           |      | kΩ |
|                               |                               | RI                | When PE1 has the open-drain specifications.                                     |   | WDR                                 |     | 100 ±1%                           |      | Ω  |
|                               | Clear time (discharge)        | t <sub>WCT</sub>  | Figure 8  |   | WDR                                 | 40  |                                   | μs   |    |
|                               | Clear period (charge)         | t <sub>WCCY</sub> | Figure 8  |   | WDR                                 | 14  |                                   | ms   |    |

- Notes: 1. Allowed up to the amplitude generated when the oscillator shown in figure 3 is used with the recommended circuit constants and driven by the IC.  
2. The average over a 100 ms period.  
3. The operating  $V_{DD}$  supply voltage must be maintained from the point the HALT instruction is executed until the IC has fully entered the standby state. Applications must also assure that no chattering occurs on the PA3 pin during the HALT instruction execution cycle.  
4. Recommended circuit constants that have been verified to oscillate stably according to the oscillator element manufacturer using the Sanyo-stipulated oscillator characteristics evaluation board.  
5. The OSC1 pin will have Schmitt characteristics when external clock oscillator is selected with the two-pin RC oscillator option.  
6. These are the results of testing using our (Sanyo's) characteristics evaluation board with the recommended circuit constants used as external components. The current flowing in the IC's output transistors and transistors that have pull-up resistors is not included.  
7.  $f_{COSC}$  is the frequency when the recommended circuit constants from table 1 are used as external components.  
8. Indicates the time required to achieve stable oscillation from the point  $V_{DD}$  rises above the lower limit of the operating voltage range (See figure 4).  
9.  $T_{CYC} = 4 \times$  the system clock period  
10. If the application could be used in an environment in which condensation is possible, extra care with respect to the leakage between PE1 and adjacent pins and leakage associated with external resistors and capacitor is required during design.



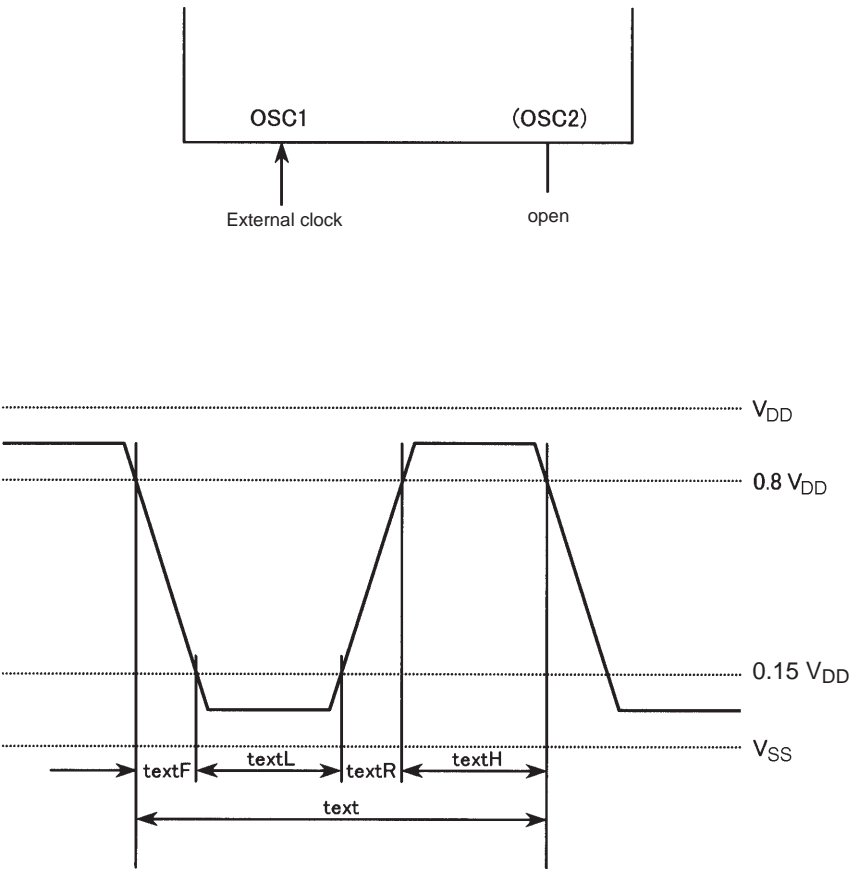


Figure 1 External Clock Input Waveform

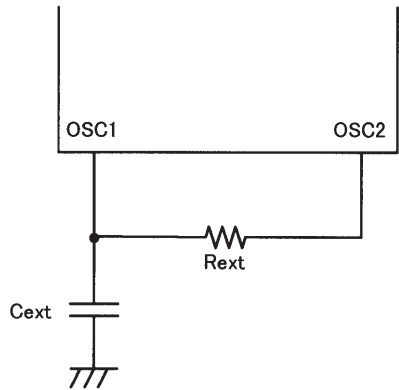


Figure 2 Two-Pin RC Oscillator Circuit

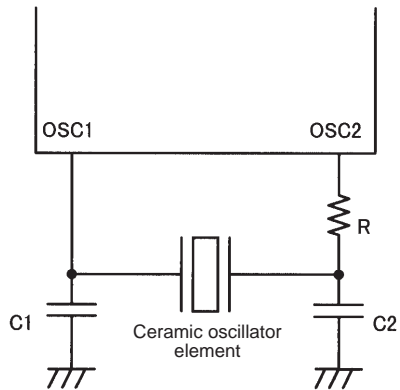


Figure 3 Ceramic Oscillator Circuit

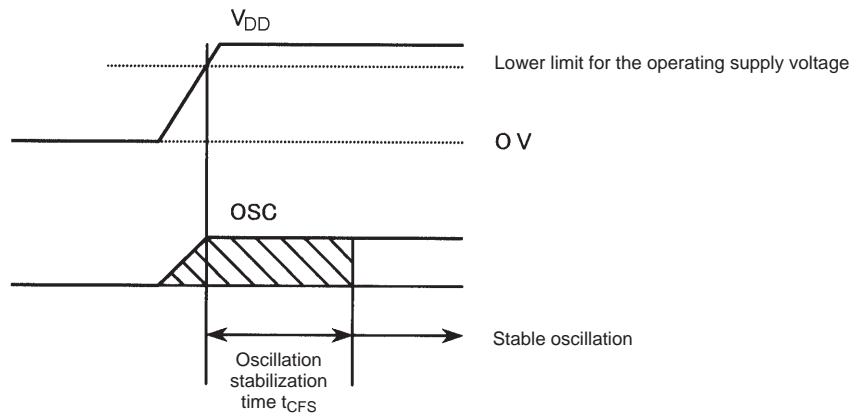


Figure 4 Oscillation Stabilization Time

Table 1 Recommended Ceramic Oscillator Circuit Constants

|  |    |                   |
|--|----|-------------------|
| 4 MHz (Murata Mfg. Co., Ltd.)<br>CSA4.00MG                                 | C1 | 33 pF $\pm 10\%$  |
|  | C2 | 33 pF $\pm 10\%$  |
|  | R  | 0 $\Omega$        |
| 4 MHz (Kyocera Corporation)<br>KBR4.0MSA<br>KBR4.0MKS (Internal capacitor) | C1 | 33 pF $\pm 10\%$  |
|  | C2 | 33 pF $\pm 10\%$  |
|  | R  | 0 $\Omega$        |
| 1 MHz (Murata Mfg. Co., Ltd.)<br>CSB1000J                                  | C1 | 100 pF $\pm 10\%$ |
|  | C2 | 100 pF $\pm 10\%$ |
|  | R  | 3.3 k $\Omega$    |
| 800 kHz (Murata Mfg. Co., Ltd.)<br>CSB800J                                 | C1 | 100 pF $\pm 10\%$ |
|  | C2 | 100 pF $\pm 10\%$ |
|  | R  | 3.3 k $\Omega$    |
| 400 kHz (Murata Mfg. Co., Ltd.)<br>CSB400P                                 | C1 | 220 pF $\pm 10\%$ |
|  | C2 | 220 pF $\pm 10\%$ |
|  | R  | 3.3 k $\Omega$    |

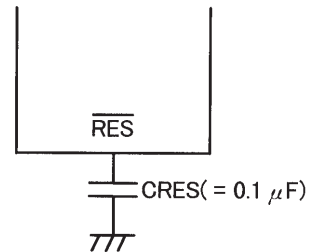


Figure 5 Reset Circuit

Note: If the power supply rise time is zero, the reset time when CRES = 0.1  $\mu$ F will be between 10 and 100 ms.  
If the power supply rise time is long, increase the value of CRES so that the reset time is at least 10 ms.

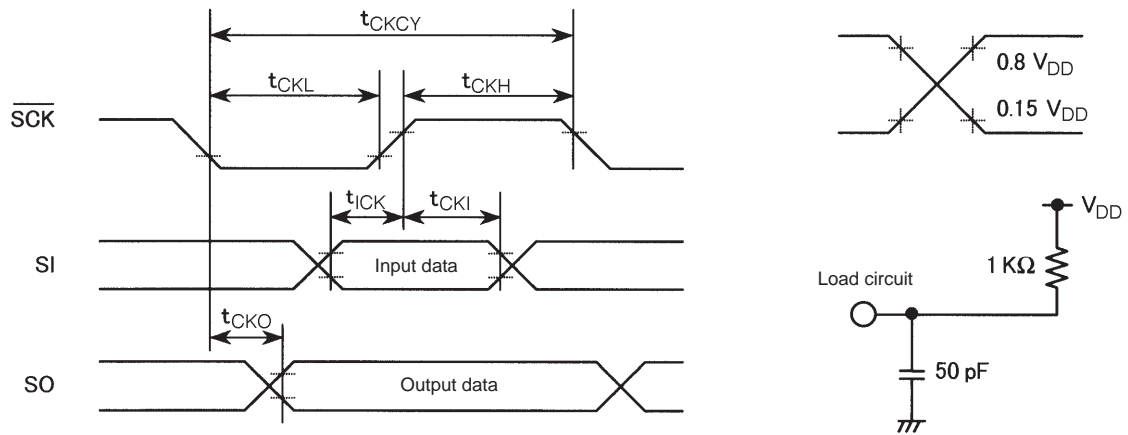


Figure 6 Serial I/O Timing

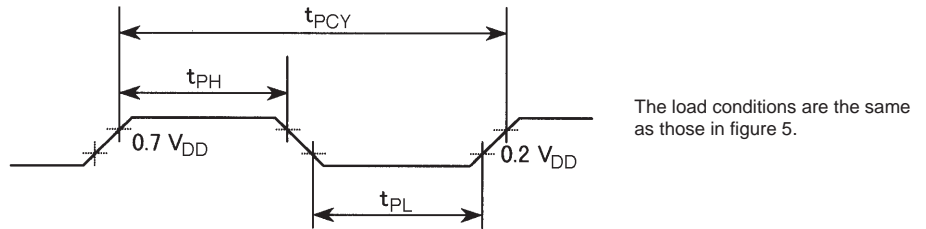
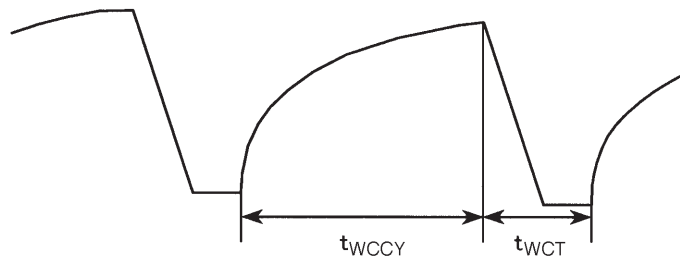
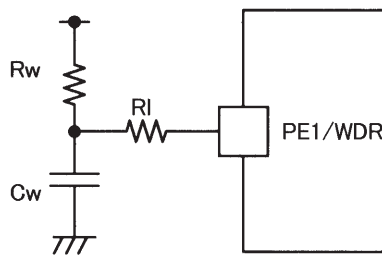


Figure 7 Port PE0 Pulse Output Timing



$t_{WCCY}$ : The charge time due to the time constant of the circuit consisting of the external components  $C_w$ ,  $R_w$ , and  $R_I$ .  
 $t_{WCT}$ : The discharge time due to software processing.

Figure 8 Watchdog Timer Waveform

# RC Oscillator Characteristics for the LC651154L and LC651152L

Figure 9 shows the RC oscillator characteristics for the LC651154L and LC651152L.

However, the sample-to-sample variation in the LC651154L and LC651152L RC oscillator frequency described below does occur.

1) When:

$V_{DD} = 2.2$  to  $6.0$  V,  $T_a = -40$  to  $+85^\circ\text{C}$

External constants:  $C_{ext} = 270$  pF

$R_{ext} = 12.0$  k $\Omega$

$f_{MOSC}$  will be:

$290$  kHz  $\leq f_{MOSC} \leq 841$  kHz

Therefore, only the above circuit constants are recommended.

If use of circuit constants other than the above is unavoidable, they must be in the following ranges.

$C_{ext} = 150$  to  $390$  pF

$R_{ext} = 3$  to  $20$  k $\Omega$

(See figure 9.)

Note 8. The oscillator frequency must be in the range  $350$  to  $850$  kHz when  $V_{DD} = 5.0$  V and  $T_a = 25^\circ\text{C}$ .

Note 9. Applications must be designed to have adequate margins so that the oscillator frequency falls in the operating clock frequency range (see the oscillator divider option table) for the voltage range  $V_{DD} = 2.2$  to  $6.0$  V and for the temperature range  $T_a = -40$  to  $85^\circ\text{C}$ .

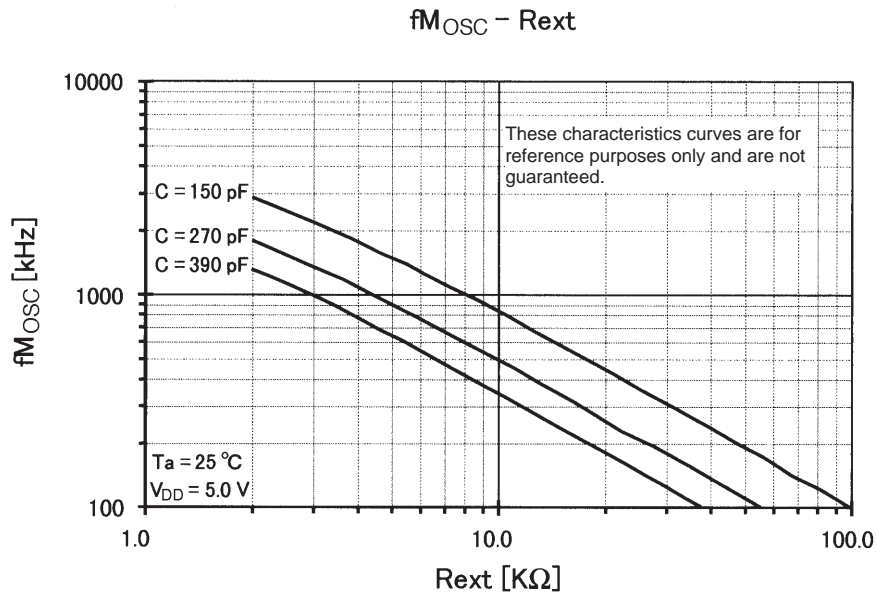


Figure 9 RC Oscillator Frequency Data (Representative Values)

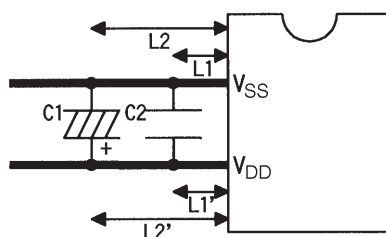
## Notes on Printed Circuit Board Design

This section describes points that require care concerning noise from the point of view of the microcontroller and presents means of preventing associated problems when designing a printed circuit board to use with these products in a mass produced end product. The ideas presented in this section are effective design techniques for preventing and avoiding problems (such as incorrect microcontroller operation and program failures) due to noise.

### 1. The $V_{DD}$ and $V_{SS}$ power supply pins

Insert capacitors that meet the following conditions between the  $V_{DD}$  and  $V_{SS}$  power supply pins.

- The lengths of the lines between the  $V_{DD}$  and  $V_{SS}$  pins and the capacitors C1 and C2 should be as close to exactly equal as possible ( $L1 = L1'$ ,  $L2 = L2'$ ). Furthermore, these distances should be as short as possible.
- Insert two capacitors, C1 and C2 in parallel, with C1 having a large capacitance and C2 having a small capacitance.
- The  $V_{DD}$  and  $V_{SS}$  lines in the printed circuit board pattern should be wider than any other lines in the pattern.



### 2. The OSC1 and OSC2 clock I/O pins

— If the ceramic oscillator option is selected (See figure 2-1.)

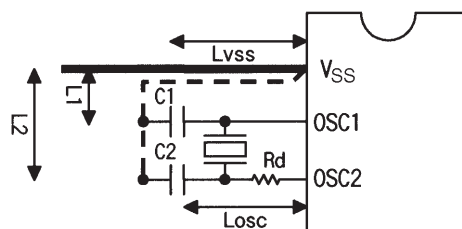
- Keep the lines between the clock I/O pins (input: OSC1, output: OSC2) and the external components as short as possible (the distance  $L_{osc}$  in the figure).
- Make the length of the lines ( $L_{vss} + L1$  and  $L_{vss} + L2$ ) from the microcontroller  $V_{SS}$  pin to the  $V_{SS}$  side of the capacitors connected to the oscillator element as short as possible.
- $V_{SS}$  line for the oscillator circuit and other  $V_{SS}$  line should branch from a point nearest to the  $V_{SS}$  pin.
- Due to the capacitances of the wiring on the printed circuit board, it may be necessary to modify the values of the oscillator circuit constants (including the values of the capacitors C1 and C2 and the limiting resistor  $R_d$ ) from the values presented in this catalog. We recommend consulting the manufacturer of the oscillator element with regard to these circuit constants.

— If the 2-pin RC oscillator option is selected (Figure 2-2)

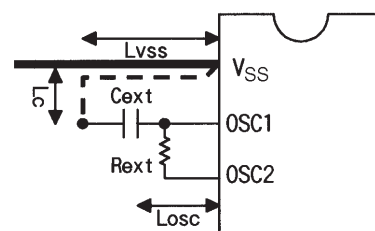
- Keep the lines between the clock I/O pins (input: OSC1, output: OSC2) and the external components (the capacitor  $C_{ext}$  and the resistor  $R_{ext}$ ) as short as possible (the distance  $L_{osc}$  in the figure).
- Make the length of the lines ( $L_{vss} + L_c$ ) from the microcontroller  $V_{SS}$  pin to the  $V_{SS}$  side of the capacitor functioning as the oscillator element as short as possible.
- Take the  $V_{SS}$  used by the oscillator circuit (as well as other  $V_{SS}$  usages) from a point as close as possible to the  $V_{SS}$  pin.

— If the external oscillator option is selected (Figure 2-3)

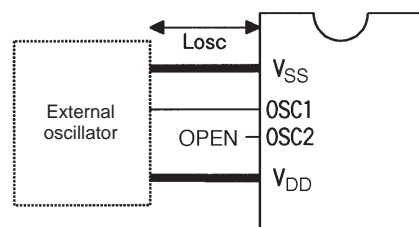
- Keep the line between the clock input pin (OSC1) and the external oscillator circuit as short as possible (the distance  $L_{osc}$  in the figure).
- Leave the clock output pin (OSC2) open.
- Make the length ( $L_{osc}$ ) of the lines to the  $V_{DD}$  and  $V_{SS}$  pins used by the external oscillator as short as possible.
- Other points that apply to all oscillator circuits:
  - Keep all lines that carry signals that change rapidly, signals that have large amplitudes due to being connected to the medium-voltage handling capacity ports, or signals that carry large currents as far away from the oscillator circuit as possible. Also, do not allow such signal lines to cross any clock-signal related lines.



**Figure 2-1 Sample Oscillator Circuit 1 (Ceramic oscillator)**



**Figure 2-2 Sample Oscillator Circuit 2 (2-pin RC oscillator)**



**Figure 2-3 Sample Oscillator Circuit 3 (External oscillator)**

3. RES: Reset pin

- Keep the length of lines ( $L_{res}$  in the figure) from the  $\overline{RES}$  pin to external circuits as short as possible.
- Keep the length of the lines ( $L1$  and  $L2$ ) to the capacitor ( $C_{res}$ ) inserted between  $\overline{RES}$  and  $V_{SS}$  as short as possible.

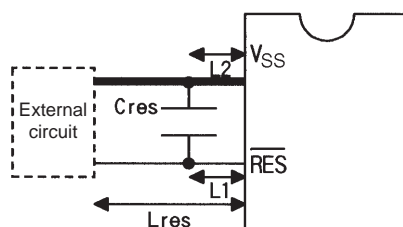


Figure 3  $\overline{RES}$  Pin Wiring

4. TEST: Test pin

- Keep the length of the line ( $L$ ) from the TEST pin to the  $V_{SS}$  pin as short as possible.
- Run the line from the TEST pin to the  $V_{SS}$  pin as close to the  $V_{SS}$  pin as possible.

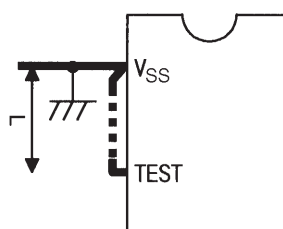


Figure 4 TEST Pin Wiring

5. AD0 to AD7: Analog input pins

Analog input pin lines, such as those used to connect to an A/D converter input pin or a comparator input pin should be connected so as to meet the following conditions.

- Keep the line ( $L1$ ) between the limiting resistor ( $R1$ ) and the analog input pin as short as possible.
- Locate the capacitor inserted between the analog input pins and the  $AV-$  pin (the A/D converter reference voltage input pin) as close as possible to the  $AV-$  input pin. That is, make the line length  $L1 + L2$  as short as possible.

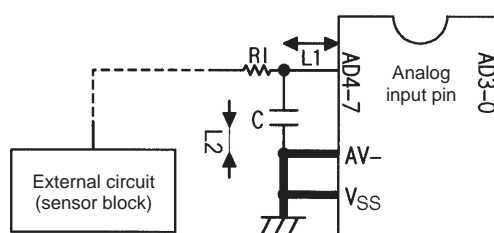


Figure 5 Analog Input Pin Wiring

6. I/O pins

All of the pins on these products function as both input and output pins.

- When used as an input pin, insert a limiting resistor, and keep the length of the line to that pin as short as possible.  
Supplement: This is not only useful in printed circuit board design, but is also useful in preventing and avoiding problems (such as incorrect microcontroller operation and program failures) by taking the program specifications and microcontroller option selections described below into consideration.
- If signals are input from external sources when the microcontroller power supply is unstable, select the medium-voltage handling capacity (n-channel open drain) output as the output type option for that input pin, and also insert a limiting resistor in the input circuit.
- Always implement key chattering exclusion measures for external signals applied to microcontroller input pins.
- The pin output data should be re-output periodically with an output instruction (OP or SPB).

- When reading data input to a pin that can function as either input or output, set the output value for that pin to 1 every time the input is read using an output instruction (OP or SPB).
7. Unused pins
- See the users manual for the product or refer to the pin functions as described in the semiconductor report for the device.

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